

# Diamond growth by plasma

**Alastair Stacey**

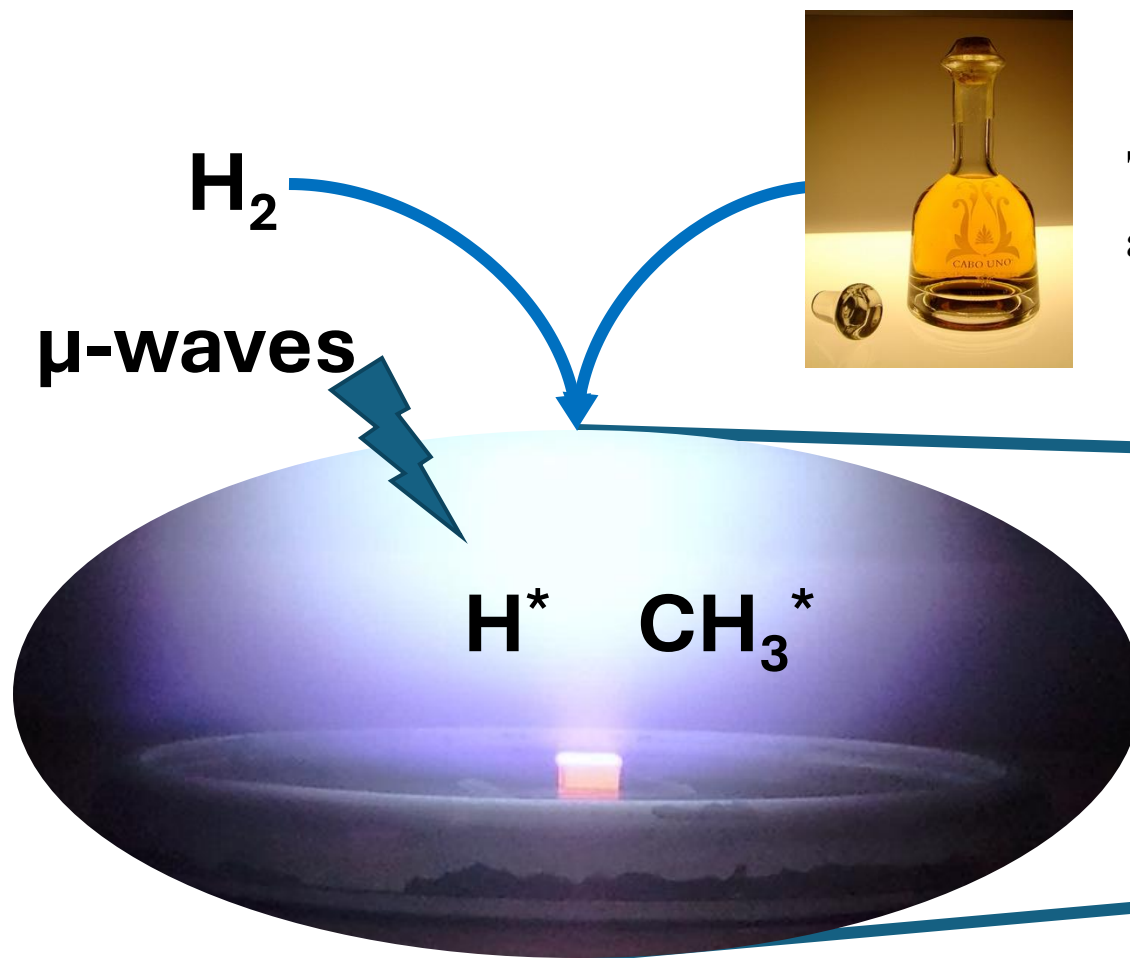
*Princeton Plasma Physics Laboratory (PPPL)*

Presented to

PPPL School on Plasmas for Microelectronics and Quantum Information Science

July 28 - August 1, 2025

# Don't do this at home!



**Tequila**  
arXiv:0806.1485v1



**And a microwave oven**

**Radical chemistry + Kinetics**  
**→ Cheating thermodynamics**

# Don't do this at home!

# Diamond Extreme Properties

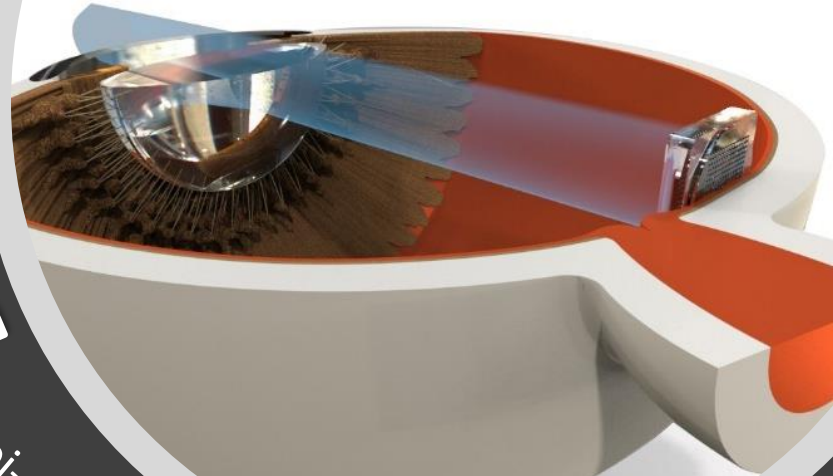
- Hardest material
- Highest thermal conductivity
- Very transparent
- Chemically inert

Acoustics



bowers-wilkins.com

Bionics



eoioxygen.com

Electro-chemistry



+ Water treatment

High Power Windows

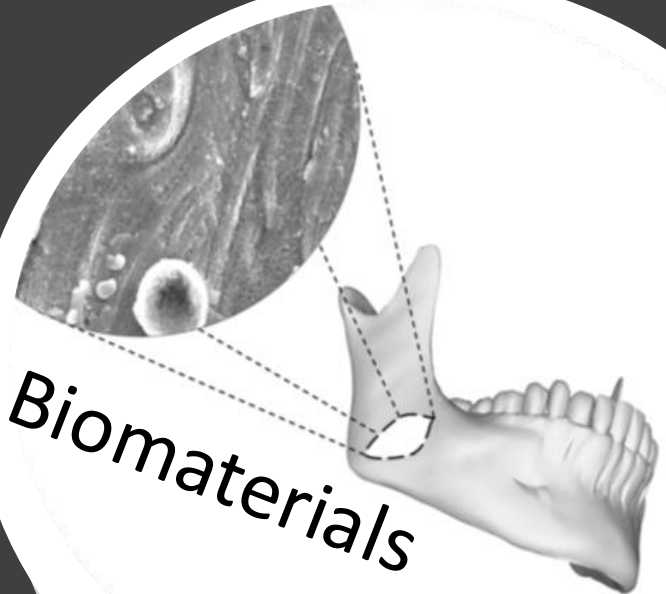


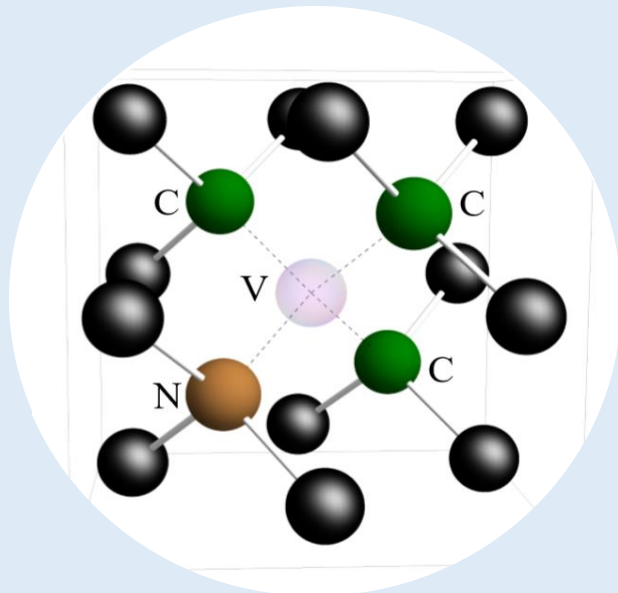
E6.com



accutome.com

Biomaterials

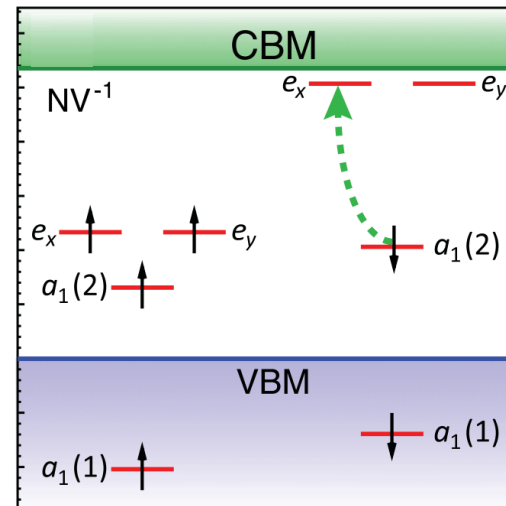




+ e<sup>-</sup>

### Diamond Material:

- Wide band-gap
- Low spin-orbit coupling
- Abundant spin-free isotopes
- High Debye temperature



$$\hat{H}_{gs} = D_{gs} \left[ \hat{S}_z^2 - S(S+1)/3 \right] + A_{gs}^{\parallel} \hat{S}_z \hat{I}_z + A_{gs}^{\perp} \left[ \hat{S}_x \hat{I}_x + \hat{S}_y \hat{I}_y \right] + P_{gs} \left[ \hat{I}_z^2 - I(I+1)/3 \right]$$

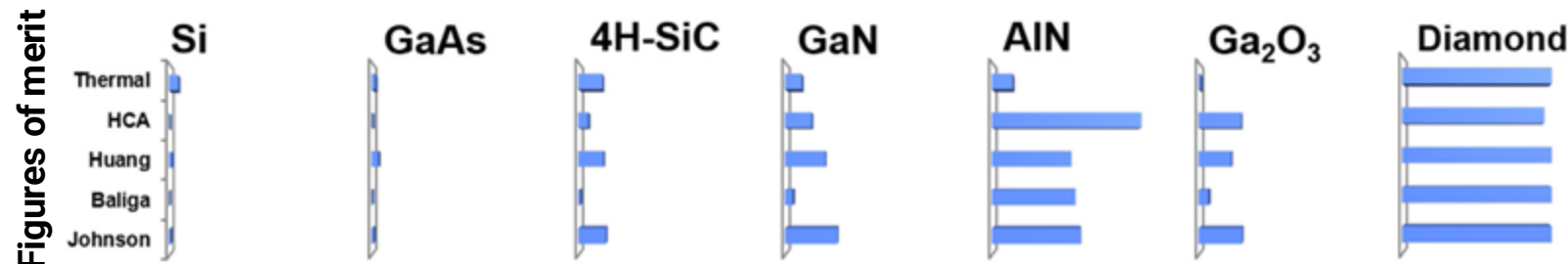
T2 > 1ms at room-temperature

- Long quantum coherence times → quantum operation
- Room-temperature operation → real-world application
- Optical initialization & readout → non-invasive nano-scale

NV defect in diamond

# Diamond Extreme Electronics: Fundamental Opportunities

| Parameter                                      | Diamond                                        | c-BN        | $\beta$ -Ga <sub>2</sub> O <sub>3</sub> | AlN   | GaN   | SiC  | GaAs  | Si    |
|------------------------------------------------|------------------------------------------------|-------------|-----------------------------------------|-------|-------|------|-------|-------|
| $\sigma_{\text{thermal}}$ (W/m·K)              | 2,290 - 3,450                                  | 940 - 2,145 | 11 - 27                                 | 319   | ≤ 253 | 370  | 55    | 145   |
| e <sup>-</sup> mobility (cm <sup>2</sup> /V·s) | 4,500                                          | 825         | 180                                     | 426   | 2,260 | 900  | 8,500 | 1,450 |
| hole mobility (cm <sup>2</sup> /V·s)           | 3,800                                          | 500         | --                                      | --    | 24    | 120  | 400   | 480   |
| $E_{\text{breakdown}}$ (MV/cm)                 | ~13.0                                          | ~17.5       | ~10.3                                   | ~15.4 | ~4.9  | ~3.0 | ~0.4  | ~0.3  |
| $v_{\text{sat}}$ (10 <sup>7</sup> cm/s)        | 2.3 (e <sup>-</sup> )<br>1.4 (h <sup>+</sup> ) | --          | 1.1                                     | 1.3   | 1.4   | 2.0  | 1.0   | 1.0   |
| Rel. permittivity                              | 5.7                                            | 7.1         | 10.0                                    | 9.8   | 10.4  | 9.7  | 12.9  | 11.8  |
| Maturity                                       |                                                |             |                                         |       |       |      |       |       |

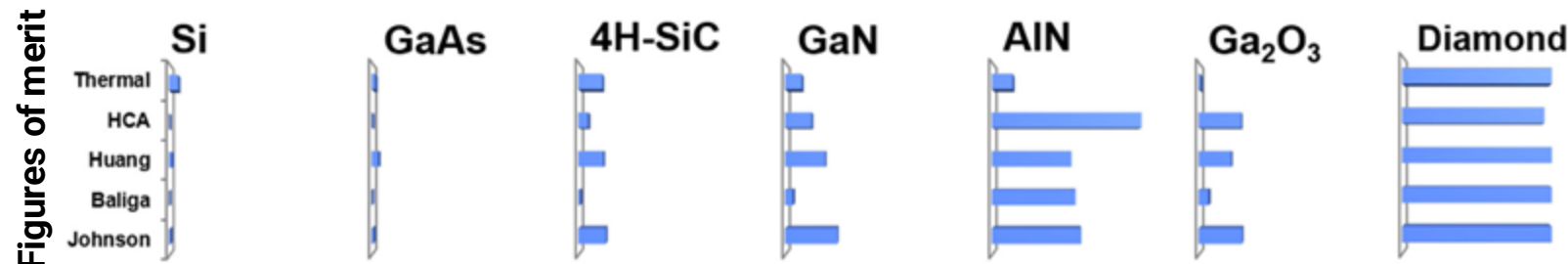


# Diamond Extreme Electronics: Fundamental Opportunities

| Parameter                                      | Diamond                                        |
|------------------------------------------------|------------------------------------------------|
| $\sigma_{\text{thermal}}$ (W/m•K)              | 2,290 - 3,450                                  |
| e <sup>-</sup> mobility (cm <sup>2</sup> /V•s) | 4,500                                          |
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| $E_{\text{breakdown}}$ (MV/cm)                 | ~13.0                                          |
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| Rel. permittivity                              | 5.7                                            |
| Maturity                                       |                                                |

## Challenges:

- > No high mobility devices (e.g. HEMT)
- > Underdeveloped doping
- > Unexplored nano-electronics
- > Untapped cold cathode properties
- > Anomalous charge transport



# Diamond Extreme Electronics: Application Areas



## High power electronics

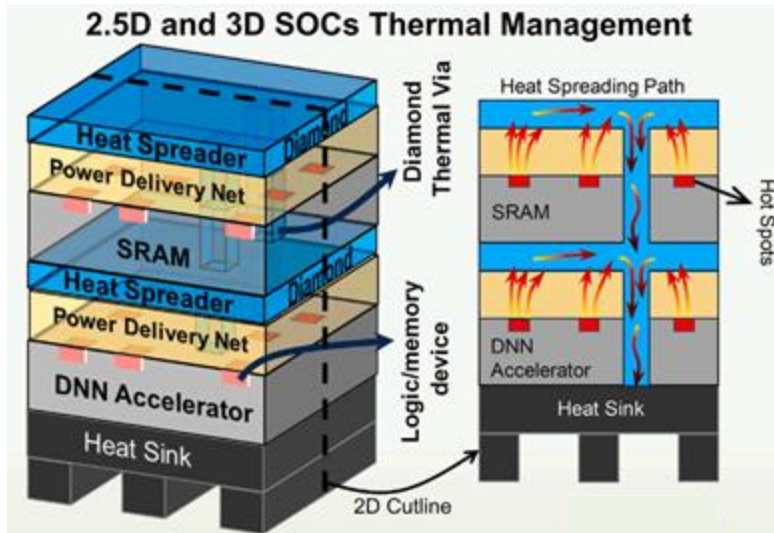
Smart Grid  
Electrification  
Defense / Aerospace

## Thermal management

High Performance  
Compute / AI  
High Power Switching

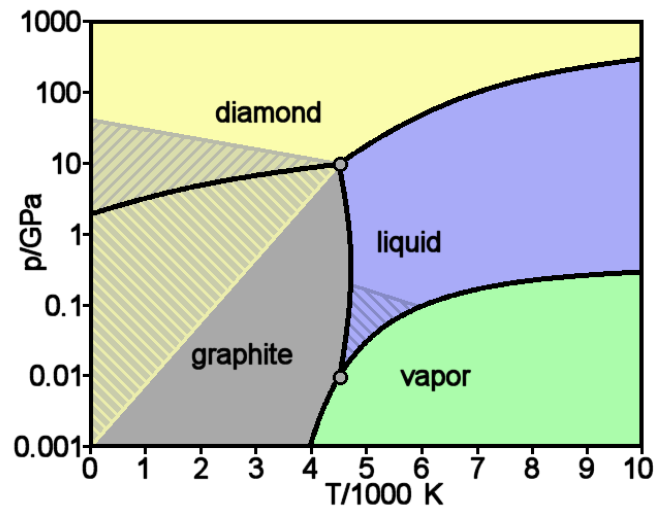
## Particle detectors

High Energy Physics  
Nuclear Technologies

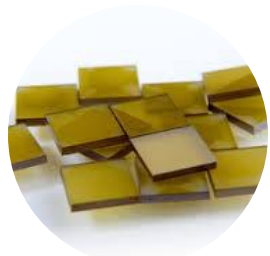
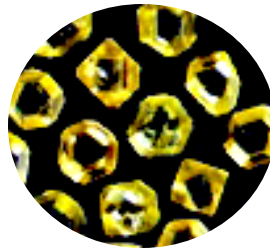




debeersgroup.com



wikimedia.com



e6.com

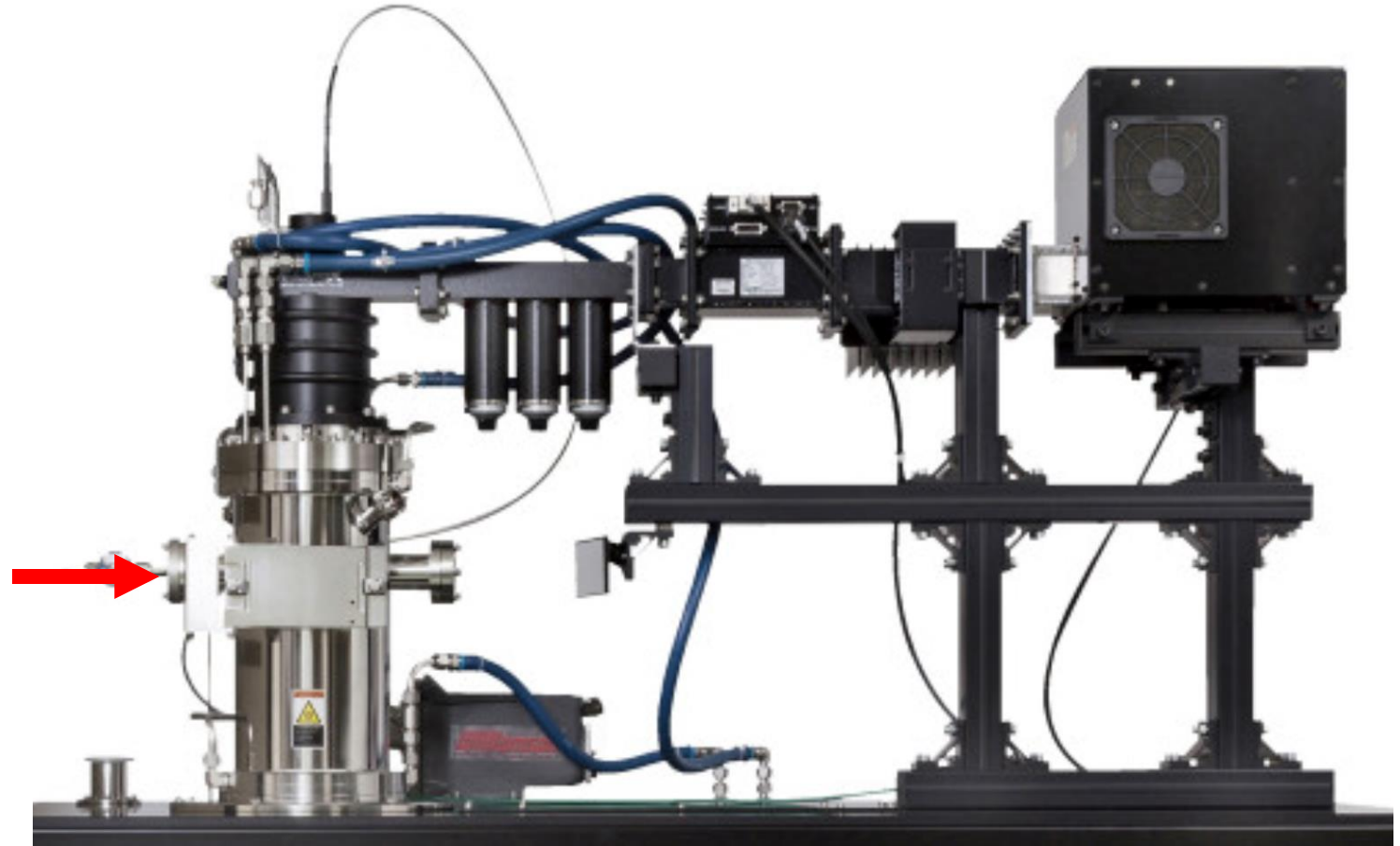
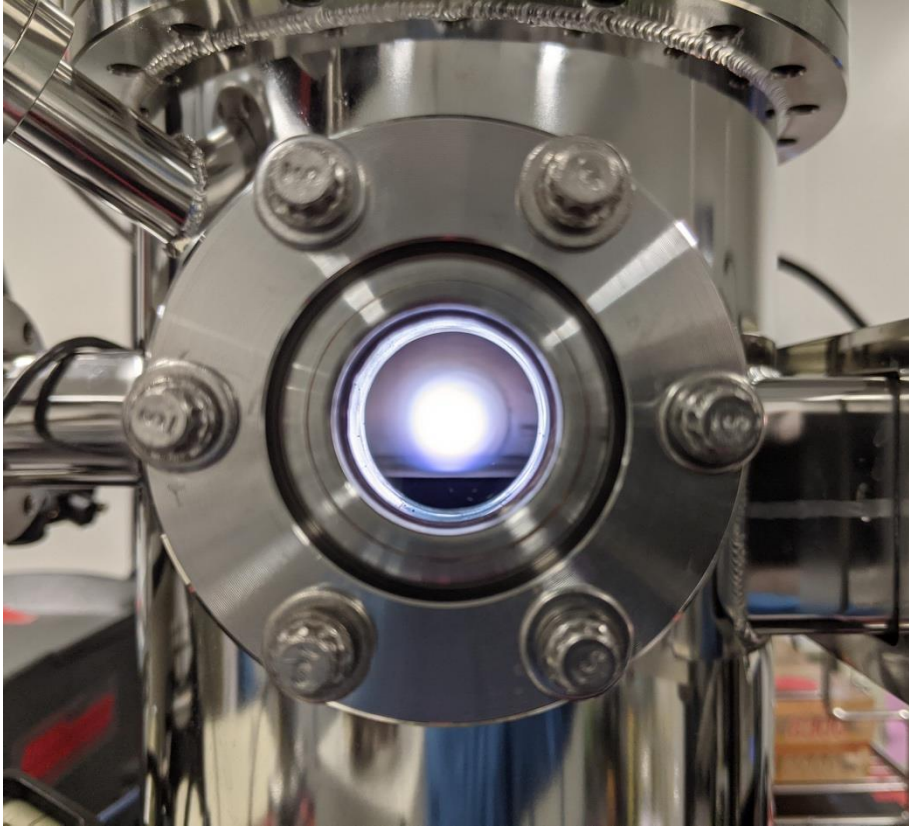
## Why is diamond annoying?

- Diamond *doesn't* want to exist at STP
- It is happy at High Pressure / High Temperature
- This is a problem for growth, but also for processing and device fabrication

# Diamond growth reactors in practice



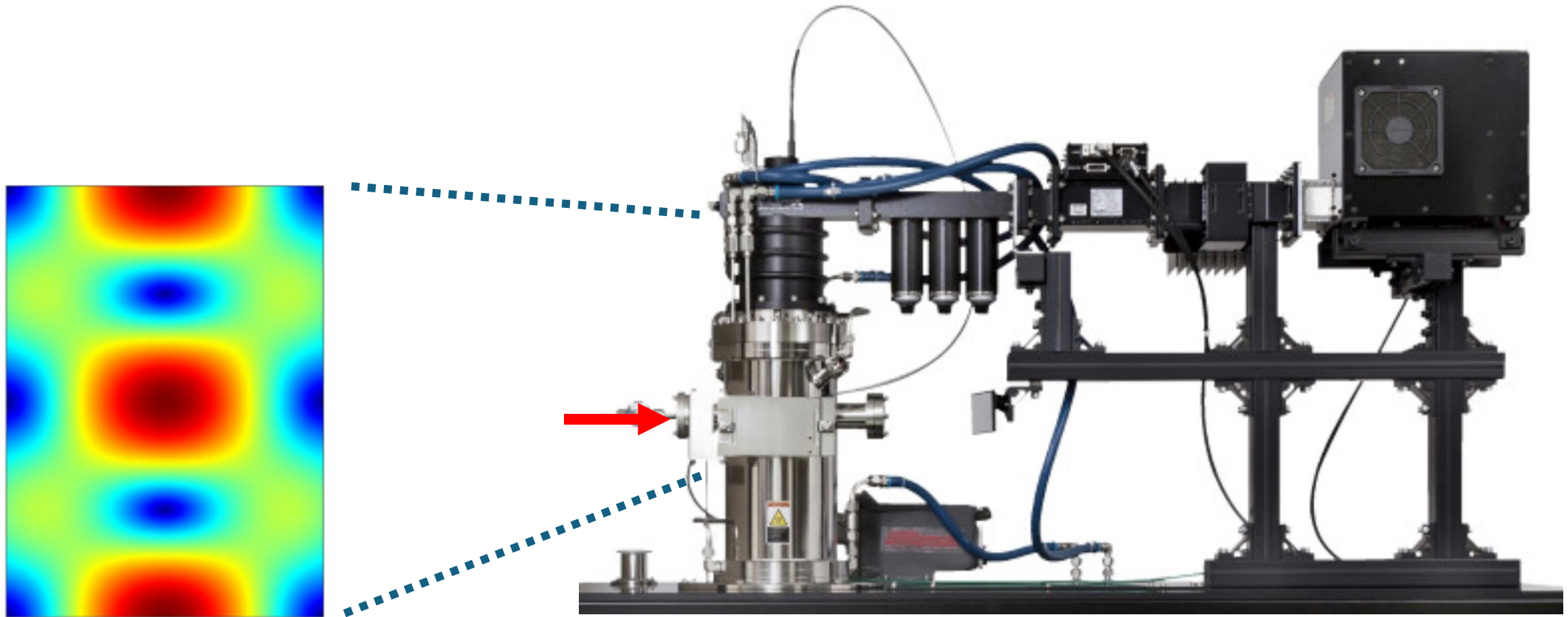
# Diamond growth MW plasma reactor



[sekidiamond.com](http://sekidiamond.com)

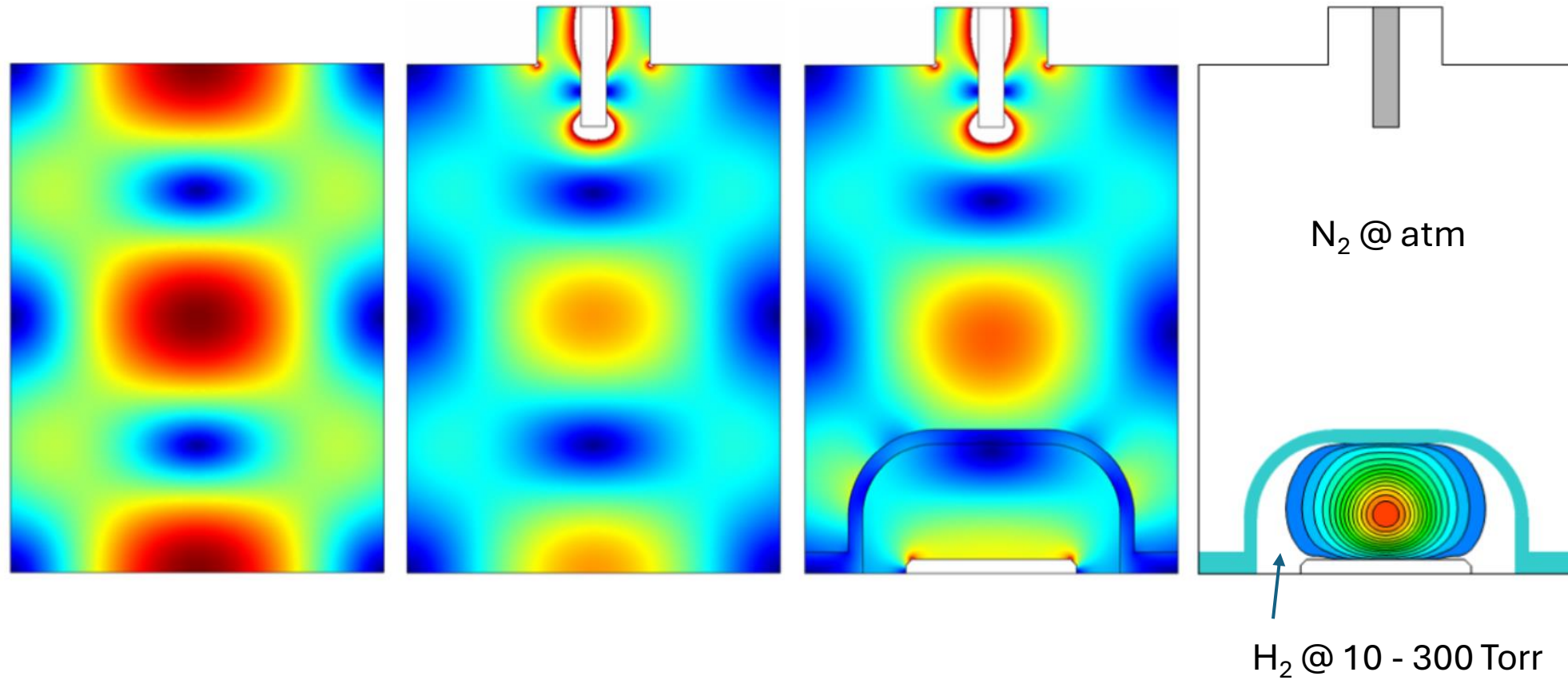


# Diamond growth MW plasma reactor

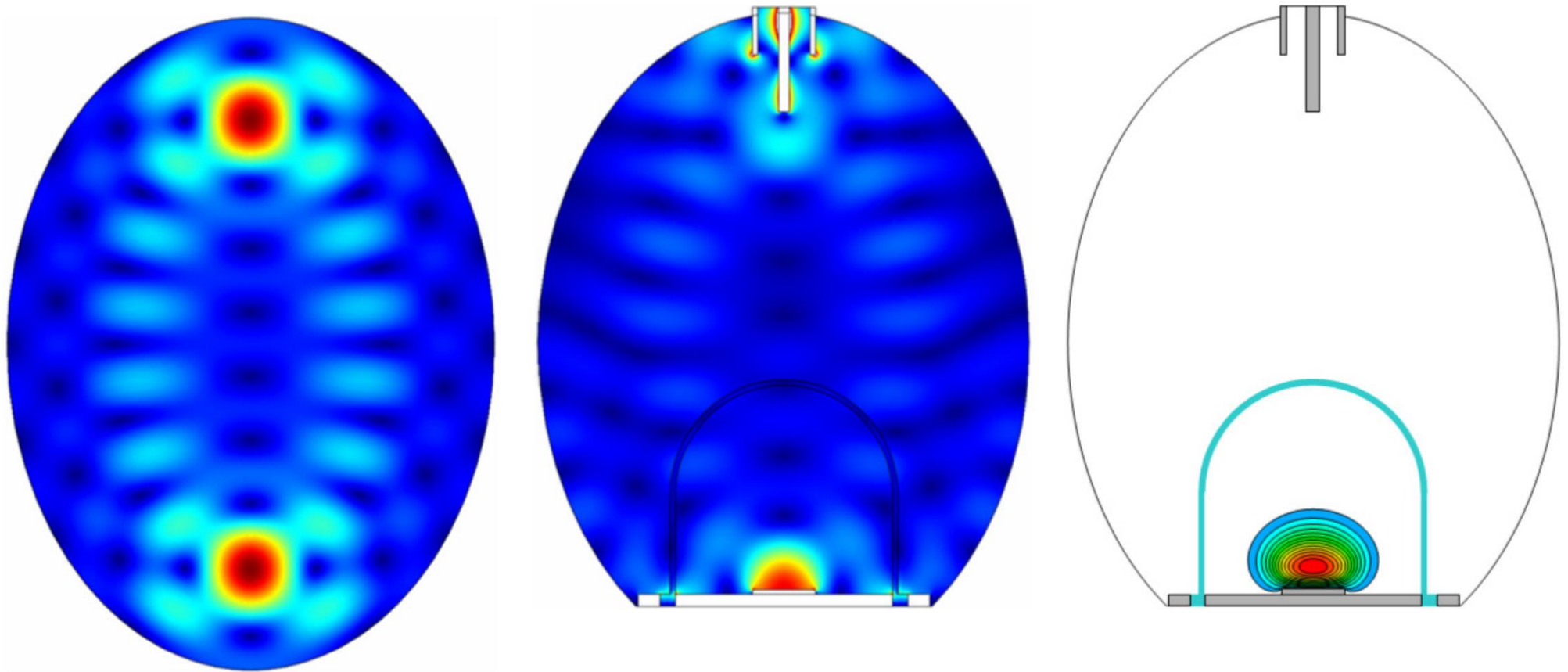


sekidiamond.com

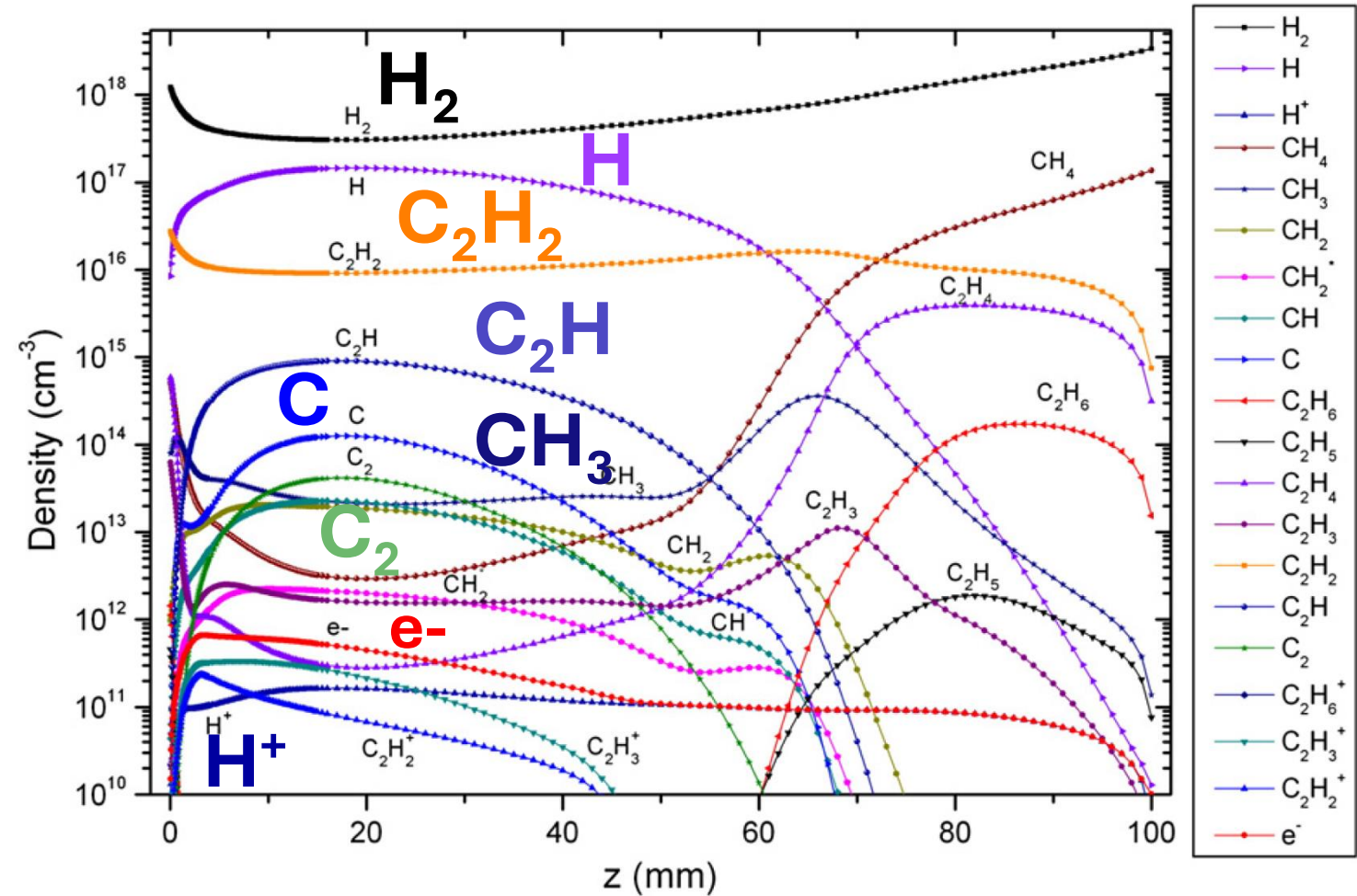
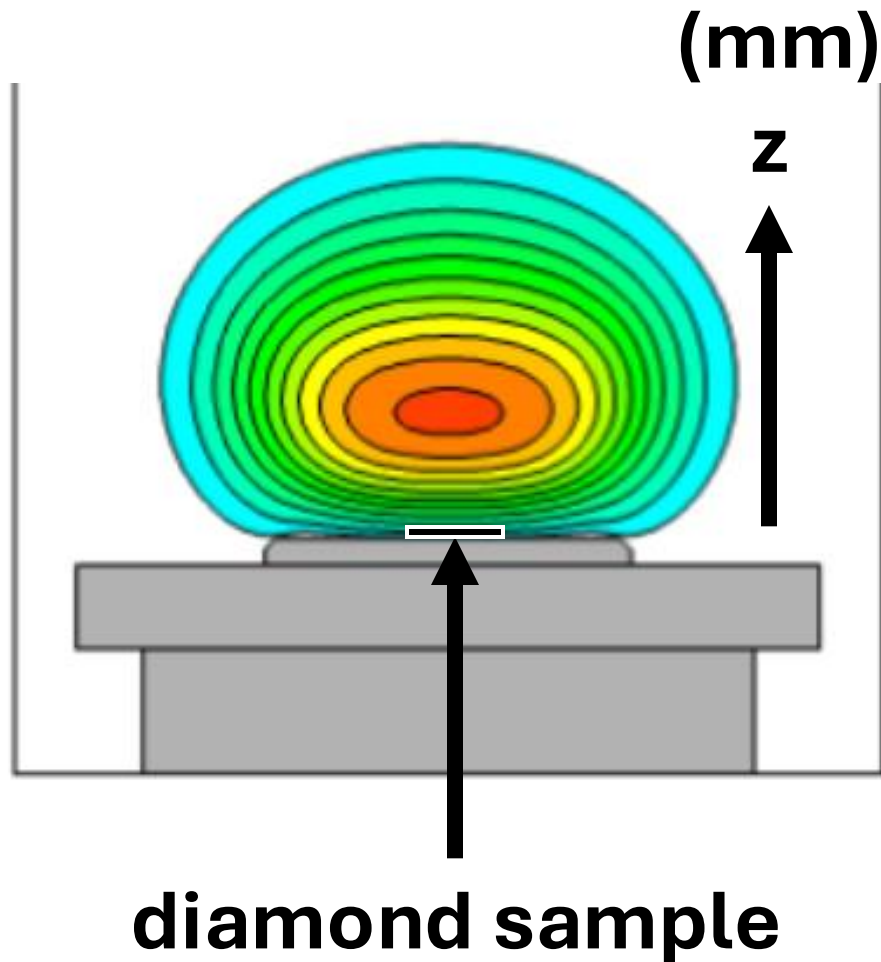
# Diamond growth MW plasma reactor



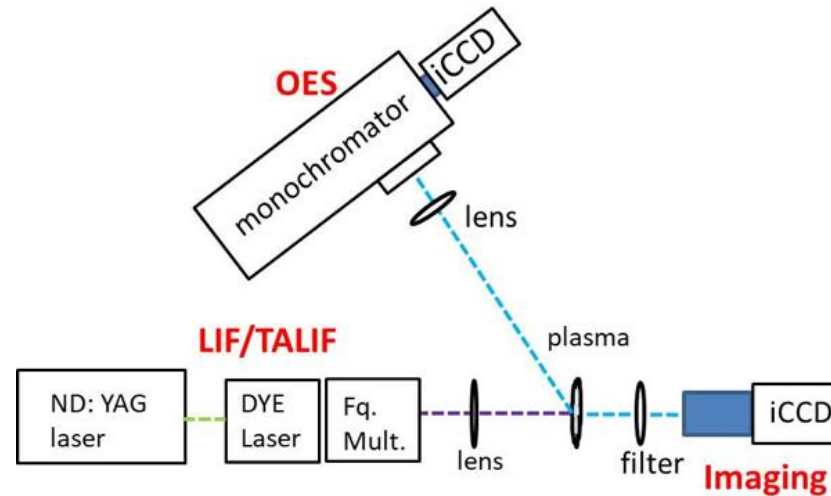
# Diamond growth plasma MW reactor



# Diamond growth plasma chemistry



# Diagnostics of Diamond Growth Plasmas: Example



$H_{\alpha}$  distribution



Two-Photon Absorption Laser-Induced Fluorescence (TALIF)

## Plasma diagnostics

- Actinometric OES
- LIF (TALIF)
- CRDS

## Frontiers

- Doping chemistry
- Model validation



Shota Abe



# Diamond surface stabilized by hydrogen

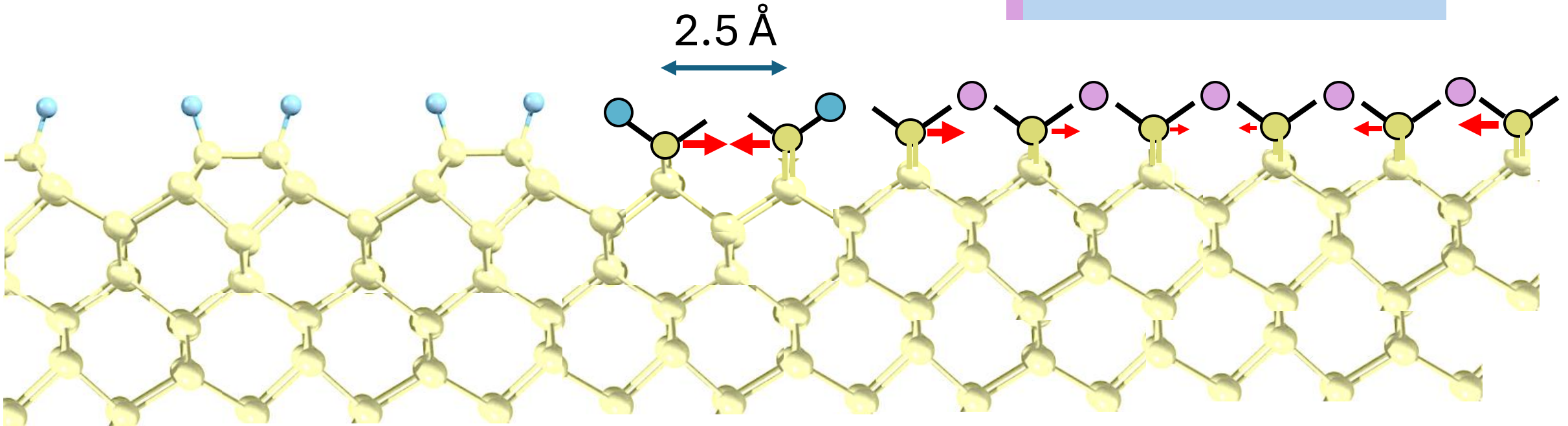
## | Dense diamond surface limits options

### Steric hindrance and dense surface sites

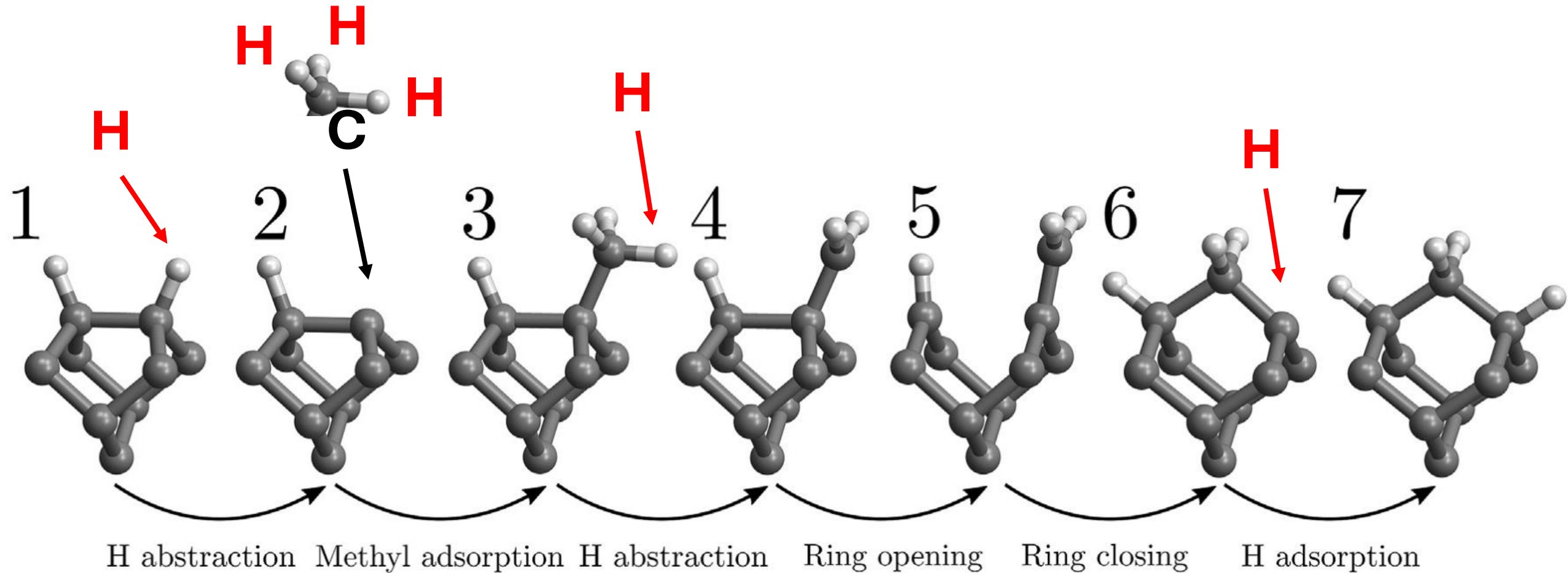
Limits reaction geometry / pathways

Limits termination chemistries

Long range order is difficult to accommodate

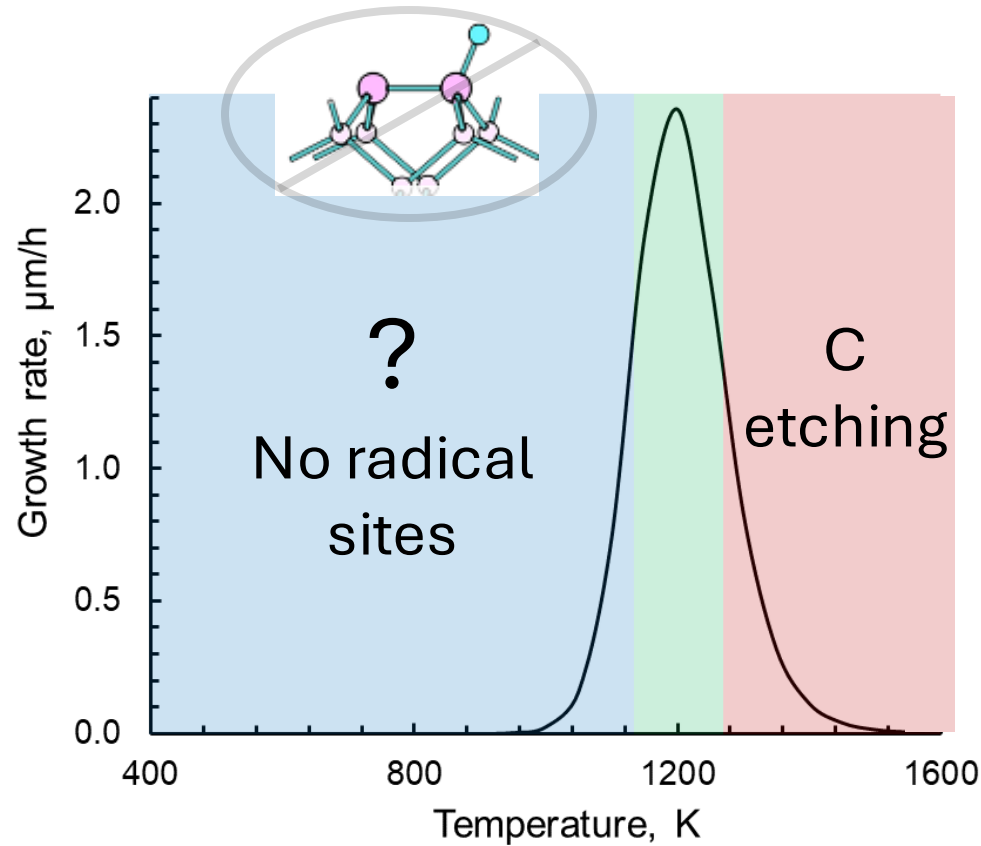


# Basic diamond growth model



## [100] diamond surface growth model

# Growth parameter windows limit co-doping options



## (100) diamond growth model

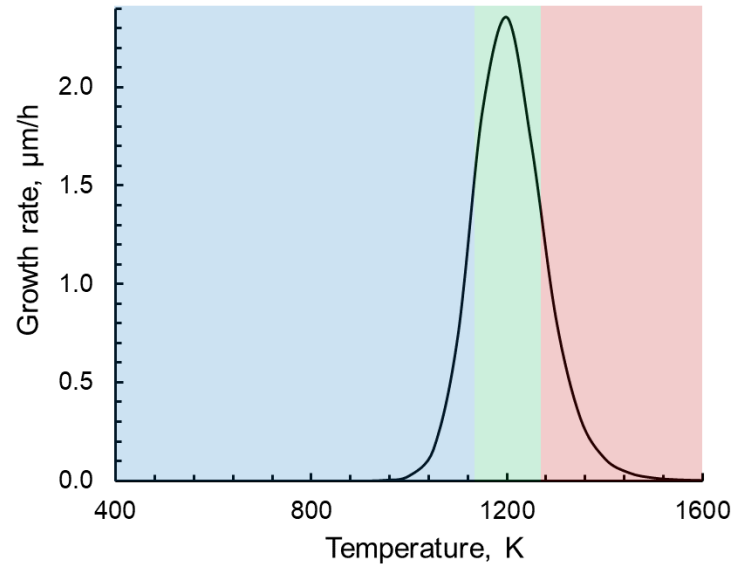
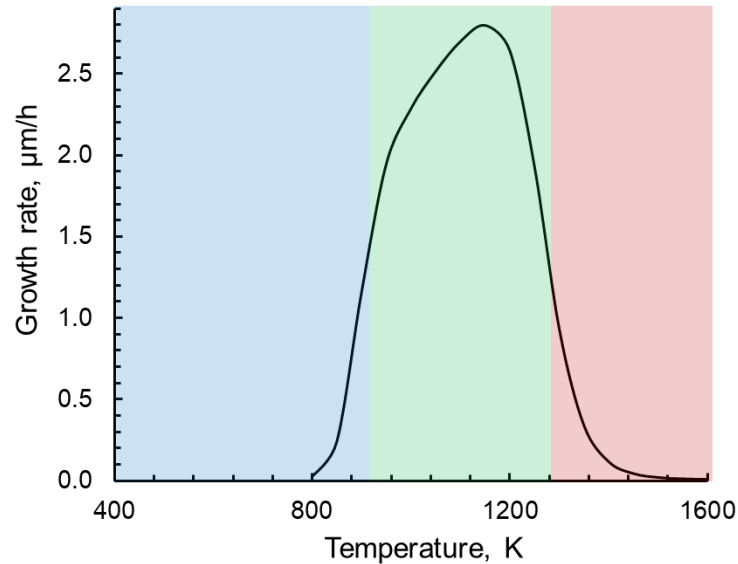
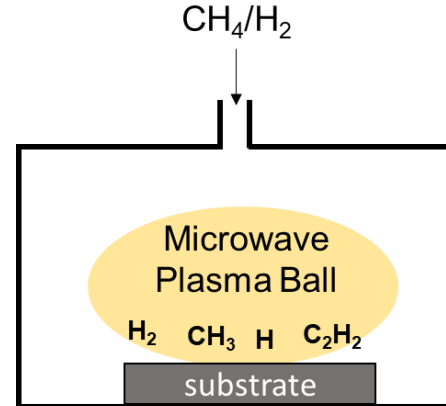
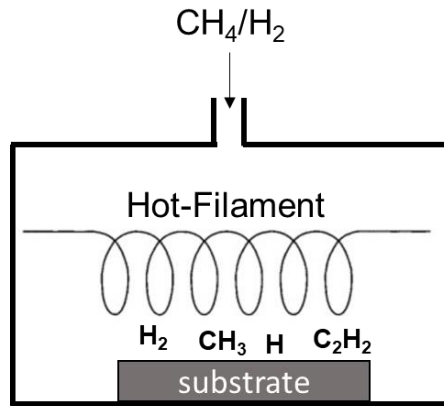
### Harris and Goodwin (1993)

- Atomic hydrogen (H)
- Methyl radicals ( $\text{CH}_3$ )

### Narrow growth window $\sim 1200$ K

- $< 1000$  K insufficient surface radical site generation (step 1)
- Increased dopant incorporation  $< 1000$  K

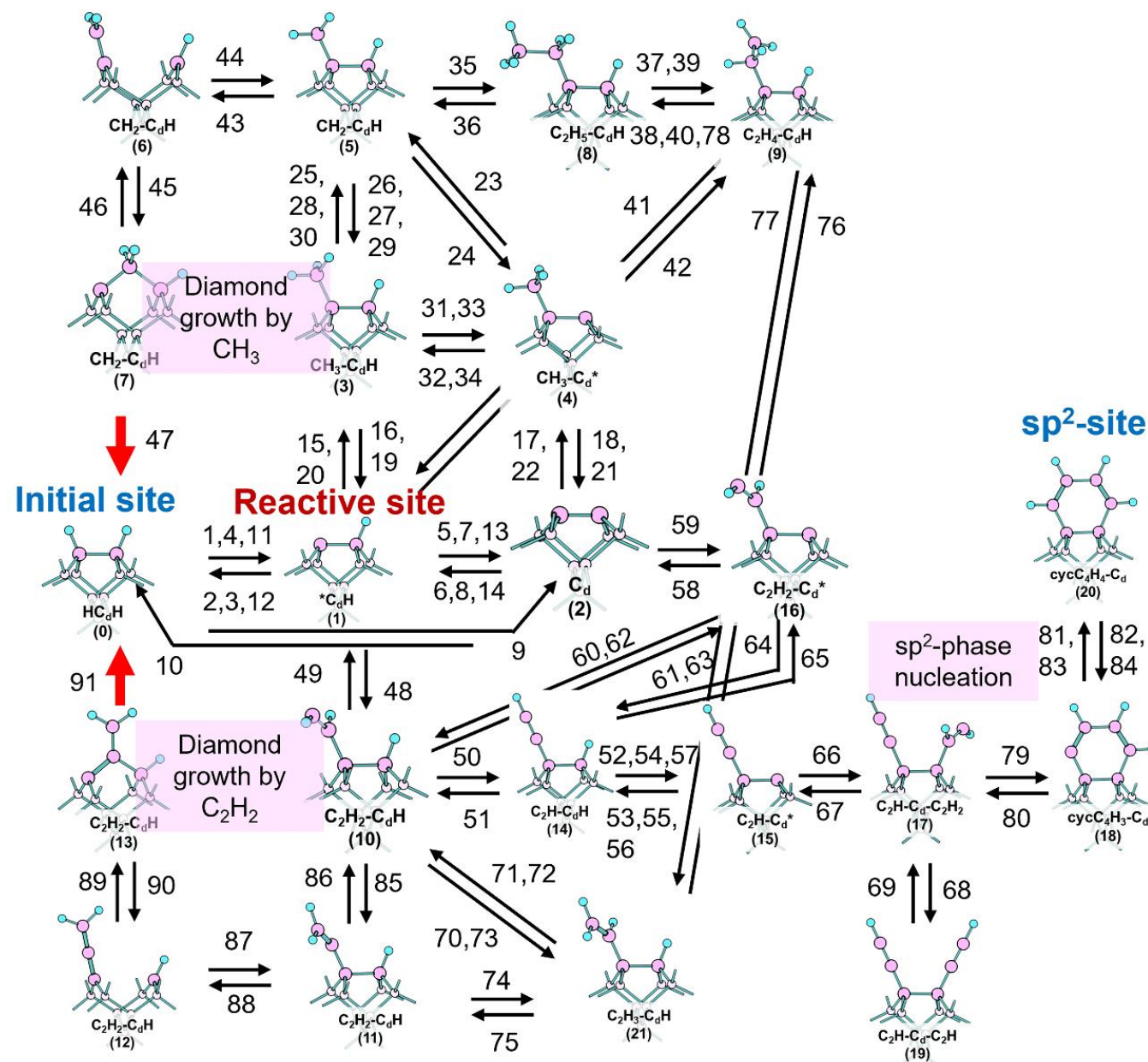
# Unexplained difference in growth windows : missing science



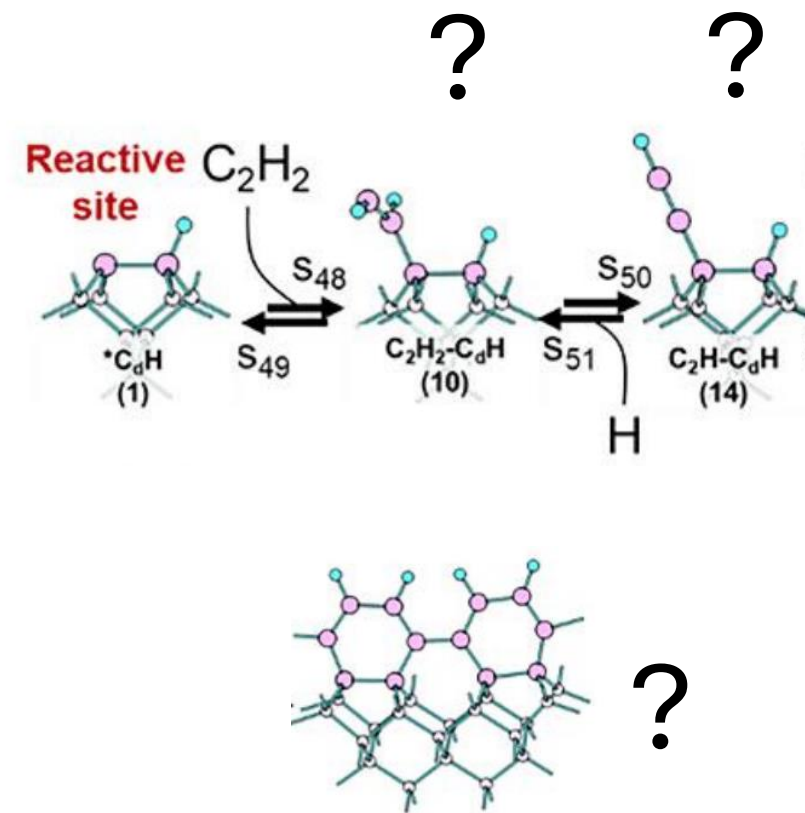
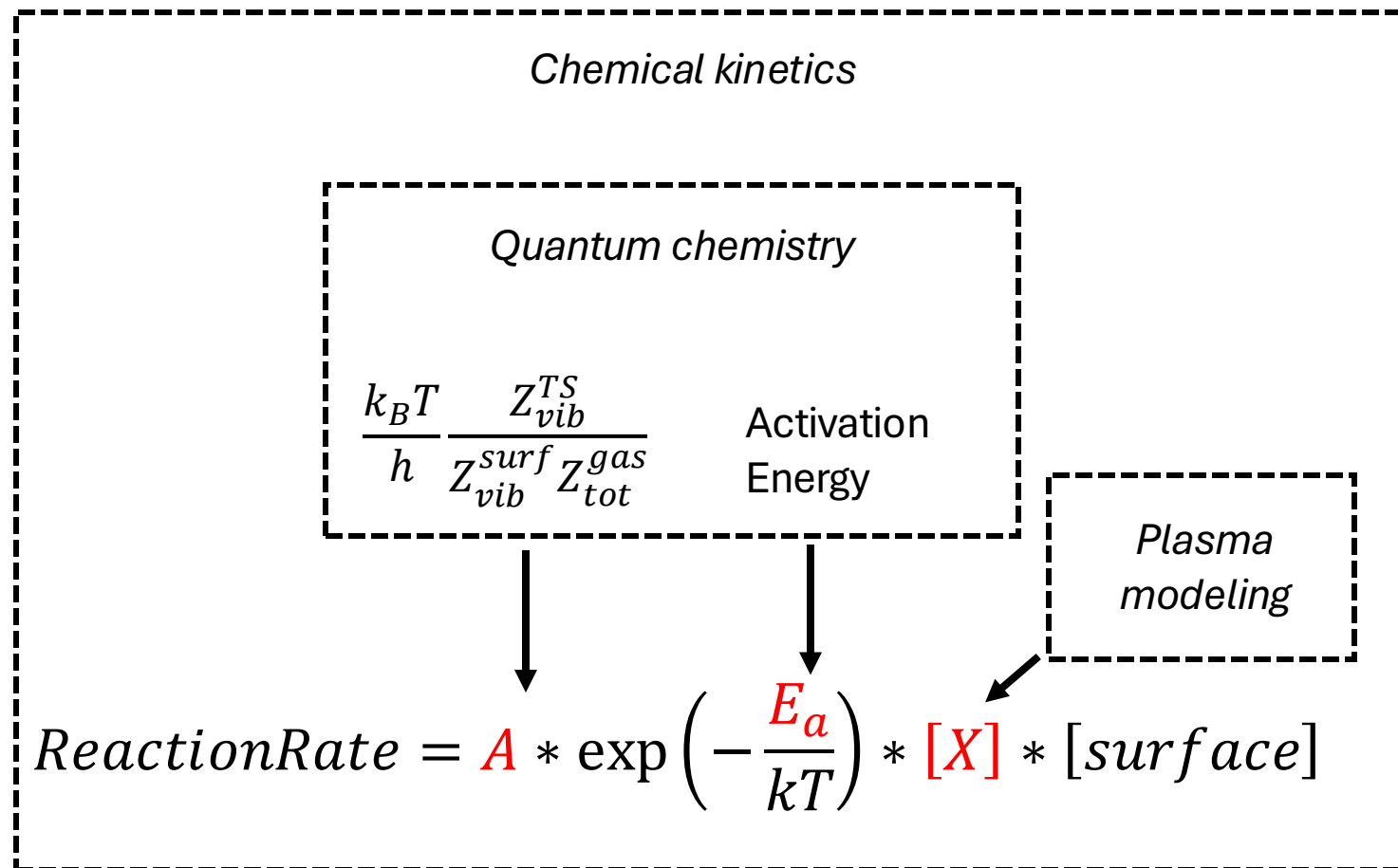
- Plasma sources both create  $\text{CH}_3$  and  $\text{H}$

→ Need new explanation for low-temperature limit of growth window

Adding chemistry  
to growth model:  
 $C_2H_2$  nucleates  $sp^2$

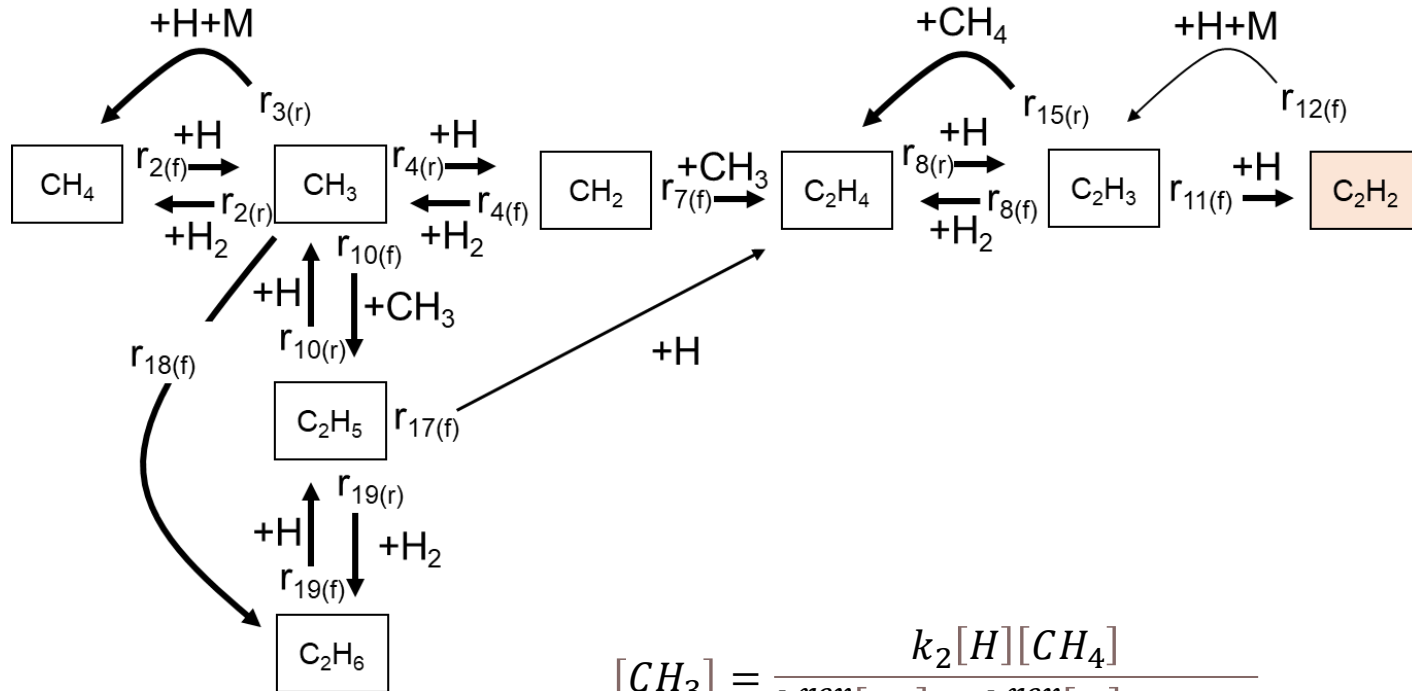


# Modeling: plasma surface interaction



→ Model predicts likely outcomes

# Gas-phase chemistry model: $C_2H_2$ fluxes depend on plasma source



## Plasma chemistry model:

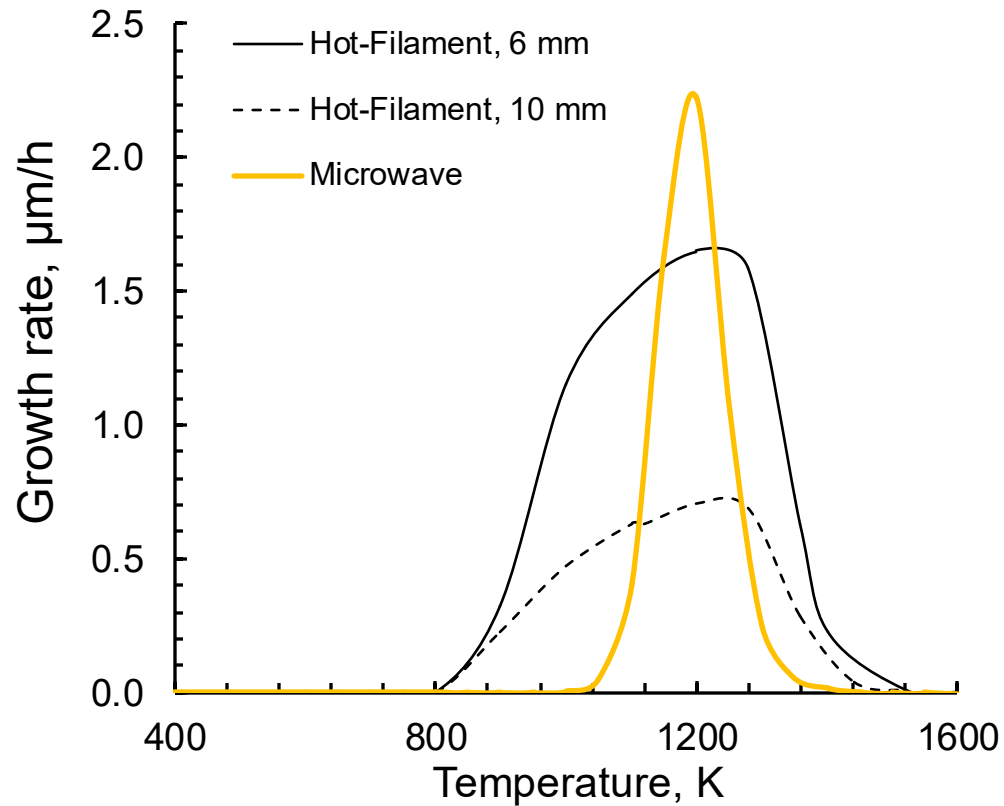
- Hot-filament systems generate lower relative  $C_2H_2$  fluxes

→ Combine plasma-chemical and quantum-chemical (surface) models to predict growth window

$$[CH_3] = \frac{k_2[H][CH_4]}{k_2^{rev}[H_2] + k_3^{rev}[H] - v_{CH_3}}$$

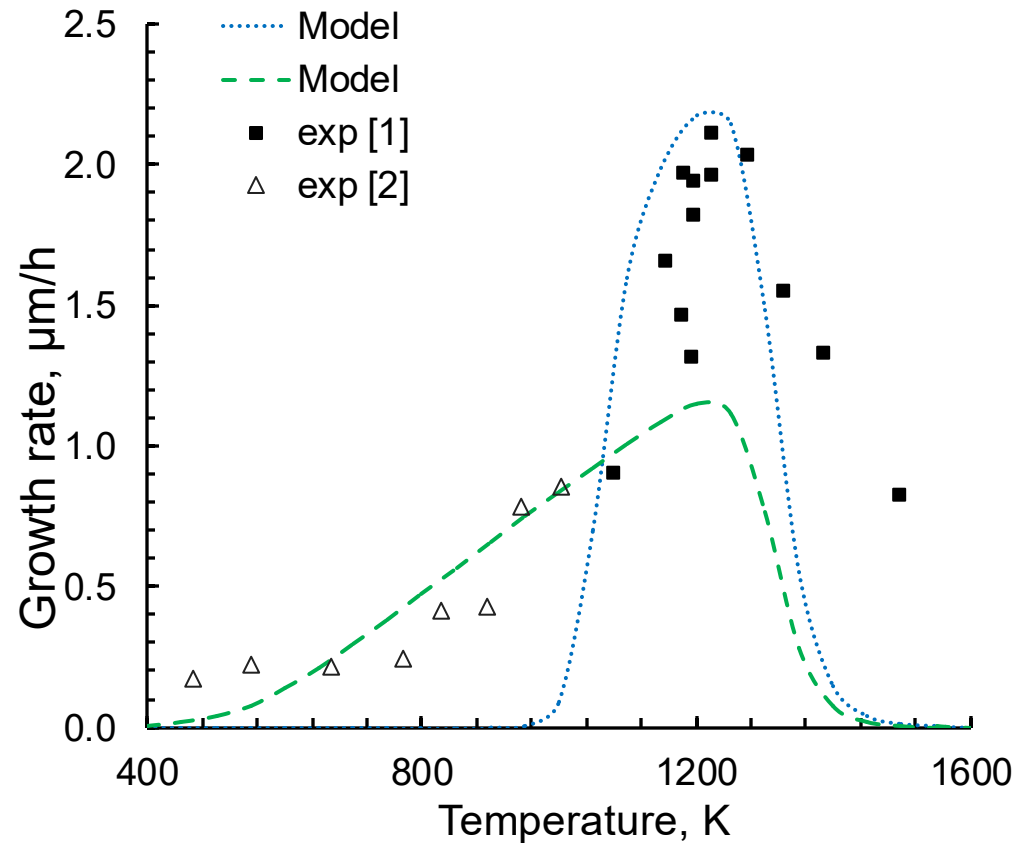
$$[C_2H_2] = \frac{(k_{11}[H] + k_{12}^{rev})/v_{C_2H_2} \times k_7 k_8 (k_5^{rev} + k_6 k_4^{rev}/k_4)[CH_3]^2[H]^2}{\{(k_8[H] - v_{C_2H_4})(k_{11}[H] + k_{12}^{rev} + v_{C_2H_3}) - k_8^{rev}[H_2]v_{C_2H_4}\} \{(k_5 + k_6^{rev})[H_2] + v_{CH_2}\}}$$

# Model confirmation: $C_2H_2$ flux limits growth rate at low temperatures



- $C_2H_2$  flux is the primary limiting factor in low temperature growth rates

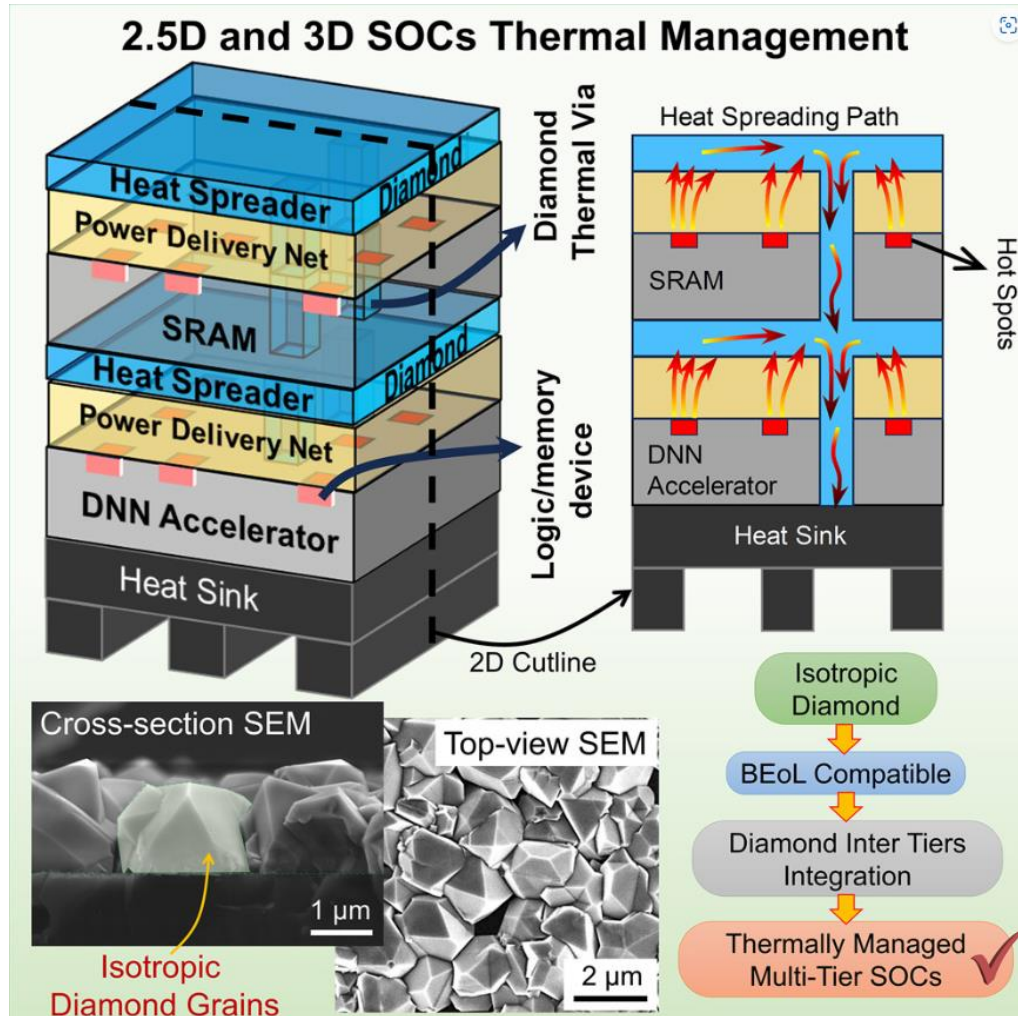
# Model confirmation: $\text{C}_2\text{H}_2$ flux limits growth rate at low temperatures



- $\text{C}_2\text{H}_2$  flux is the primary limiting factor in low temperature growth rates
- Removing  $\text{C}_2\text{H}_2$  from model enables much lower growth temps

→ Model consistent with experimental data

# Future developments: wider growth windows, full plasma models



- Low temperature growths may enable new designs for silicon electronics (SOCs)
- O<sub>2</sub> addition increases growth window but limits doping → explainable with our model

**Model-directed epitaxy development:**  
→ Lower temperature deposition for microelectronics  
→ Improved co-doping for quantum devices

# Diamond cost limitations



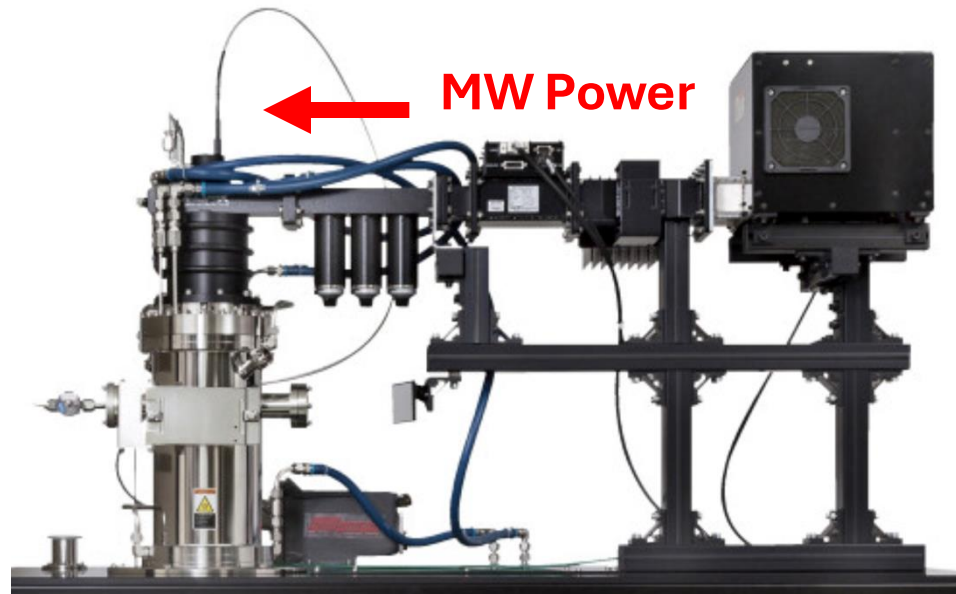
\$1,000 cm<sup>-3</sup>



\$1,000 cm<sup>-3</sup>



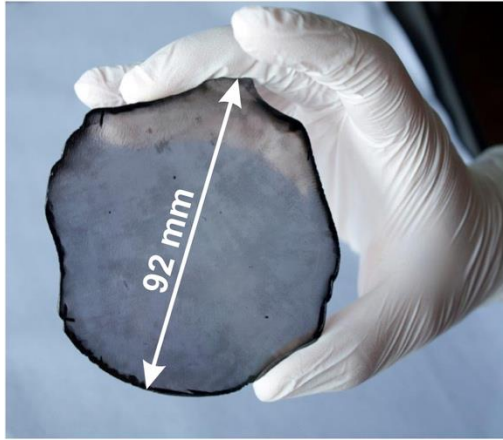
\$1 cm<sup>-3</sup>



MW Power

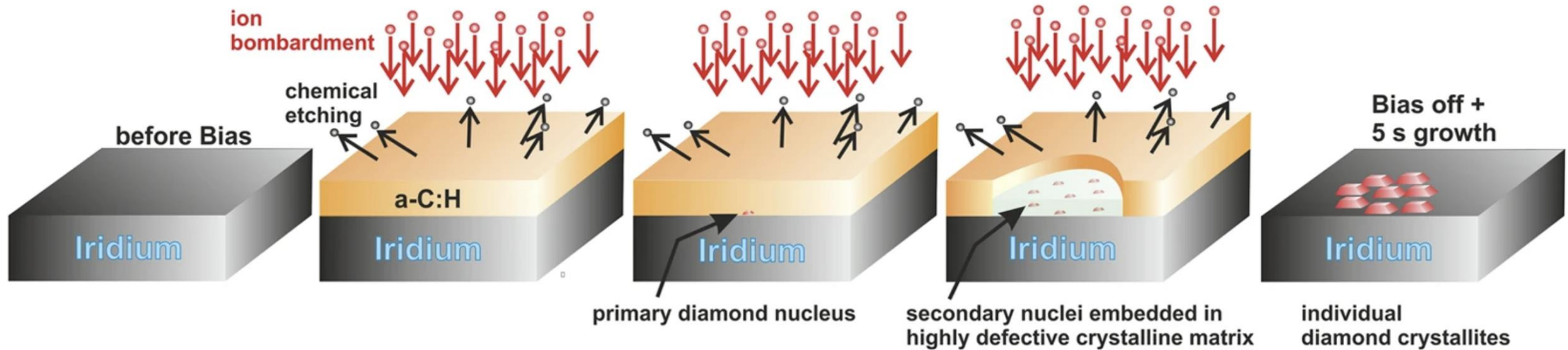
Water Cooling

# Towards wafer-scale (single-crystal) diamond

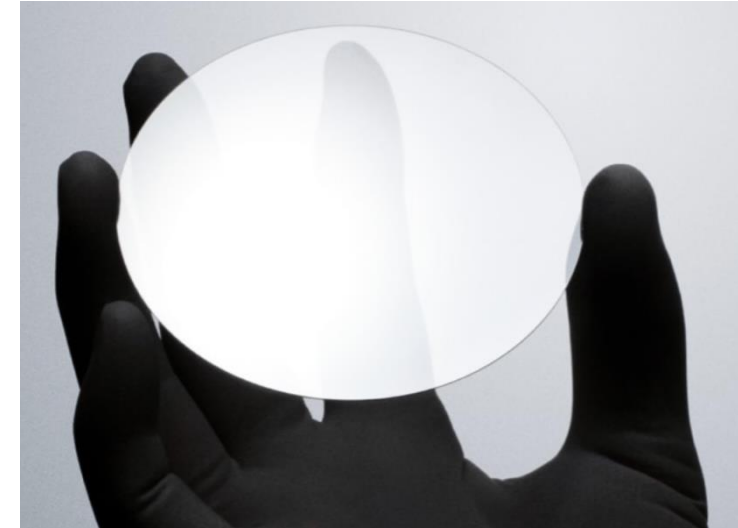
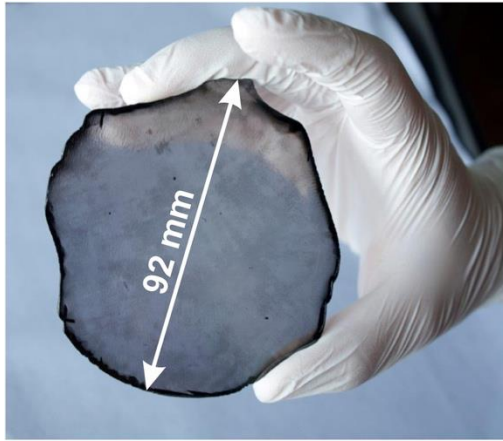


## Key Science

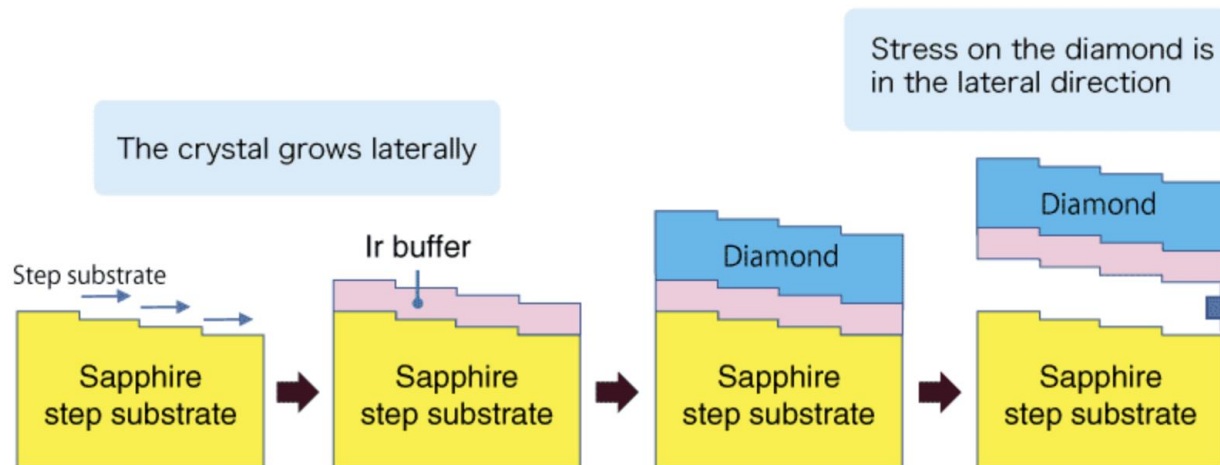
- Diamond nucleation is ‘unnatural’
- Iridium / diamond lattice mismatch ~7%
- Dislocations produced and need mitigation



# Towards wafer-scale (single-crystal) diamond

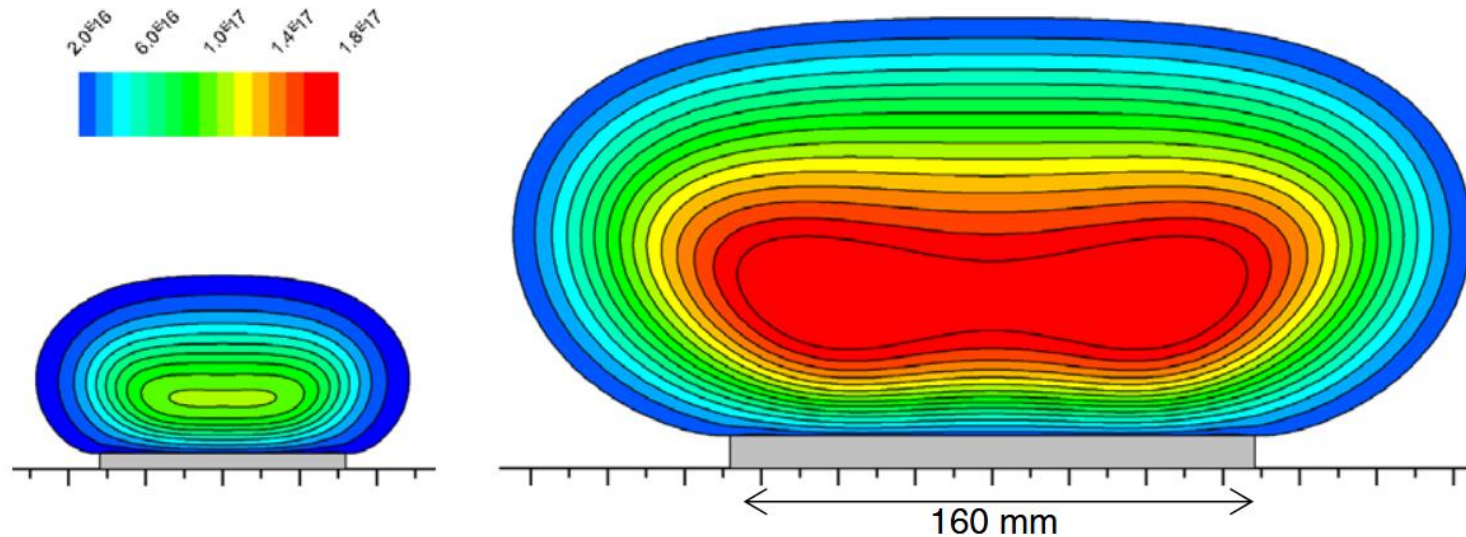


[www.df.com](http://www.df.com)



[orbray.com](http://orbray.com)

# Towards wafer-scale (single-crystal) diamond



2.45 GHz → 3"

915 MHz → 6"

? → 12"

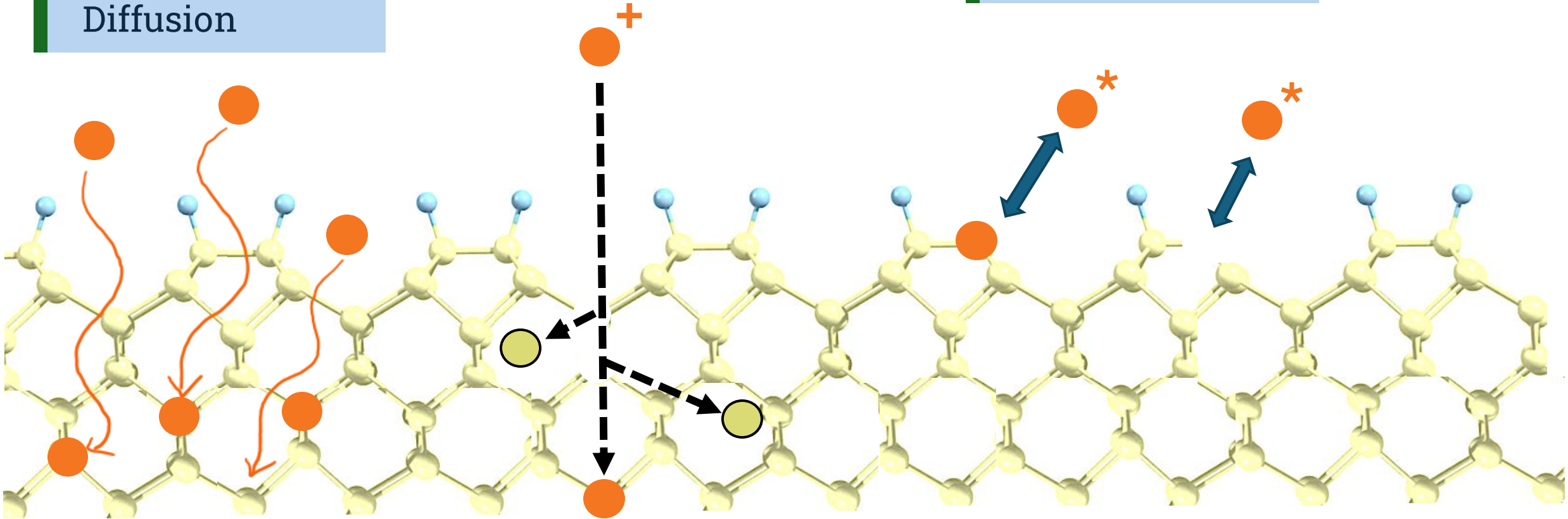
# Plasma enabled doping

Doping without plasma is hard in diamond

Diffusion

Implantation

Epitaxy



# Plasma enabled doping

Doping without plasma is hard in diamond

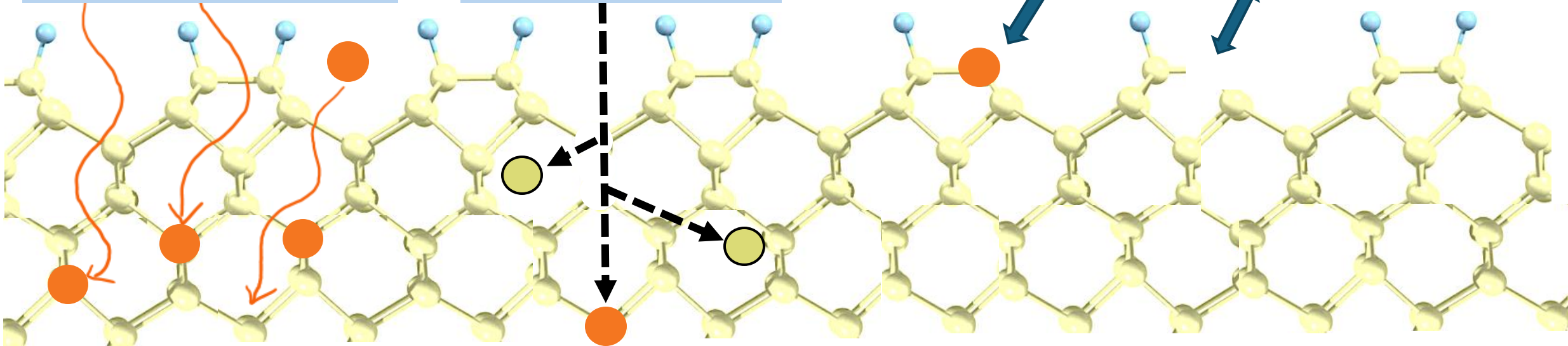
~~Diffusion~~

~~Implantation~~

Epitaxy ✓

Too hot / unstable

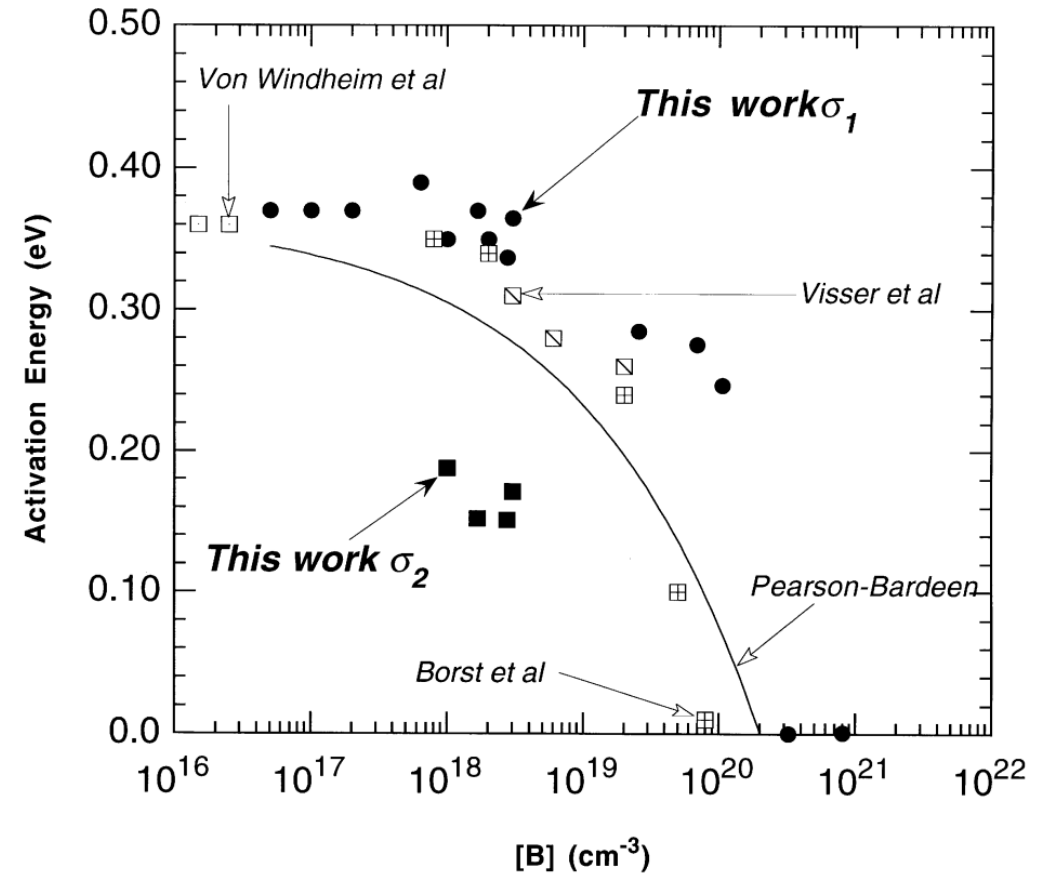
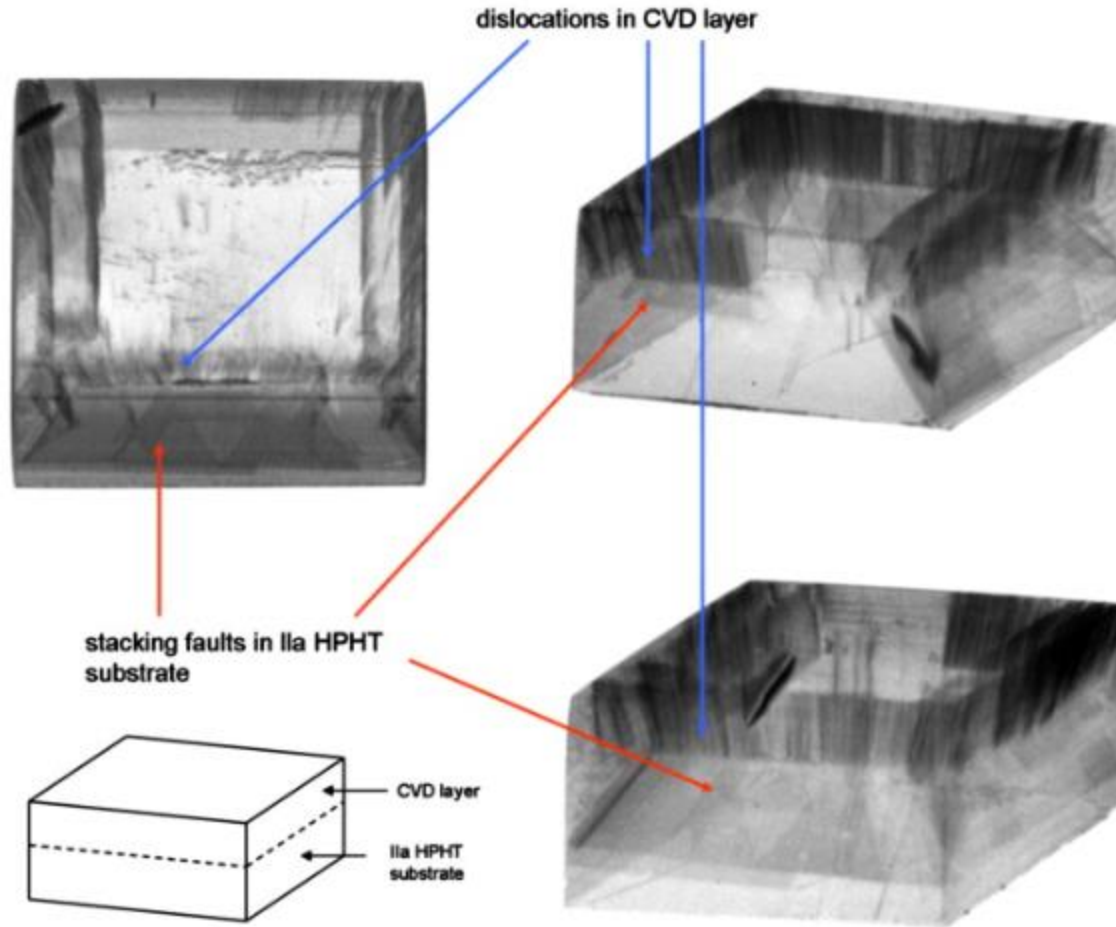
Too damaging



# Doping related issues in diamond

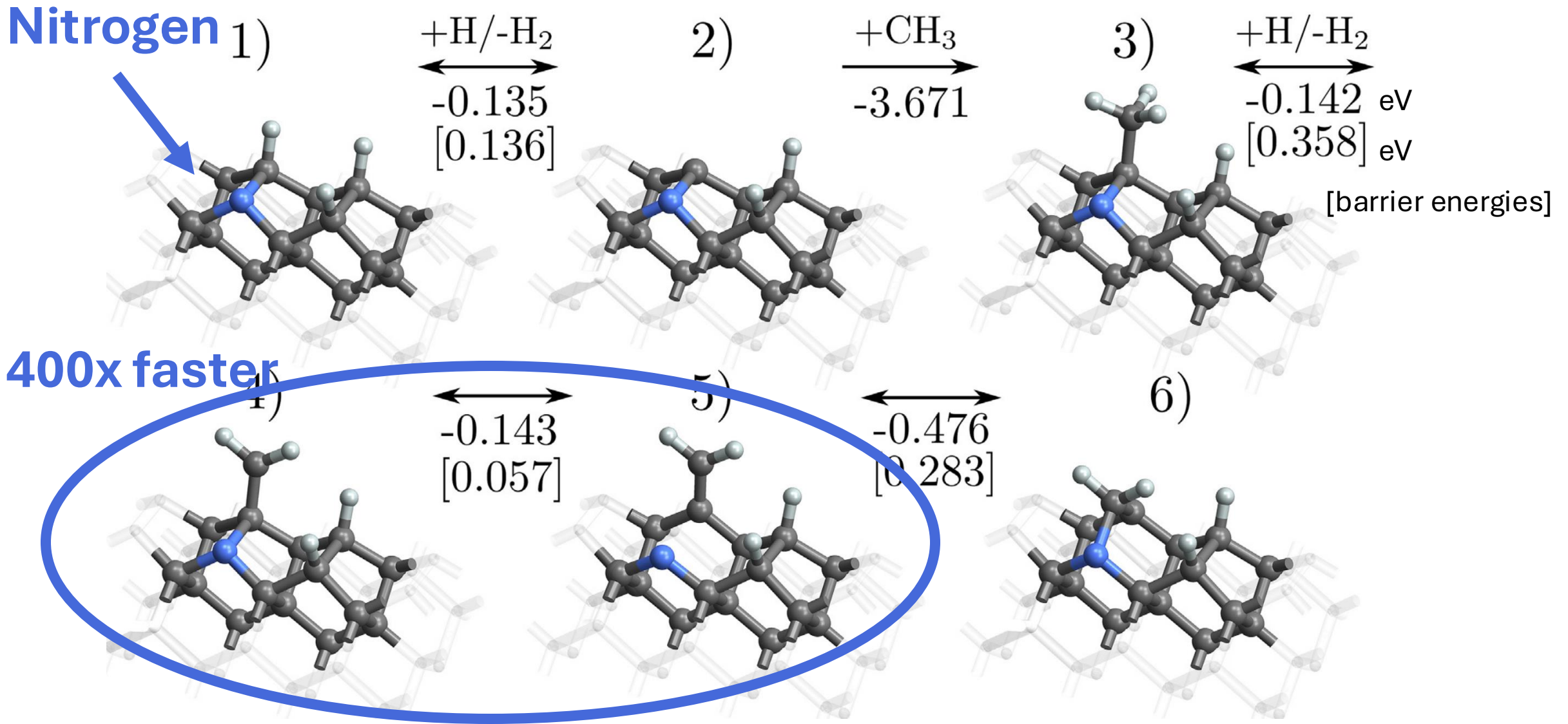
Doping can cause growth defects

High concentrations often needed



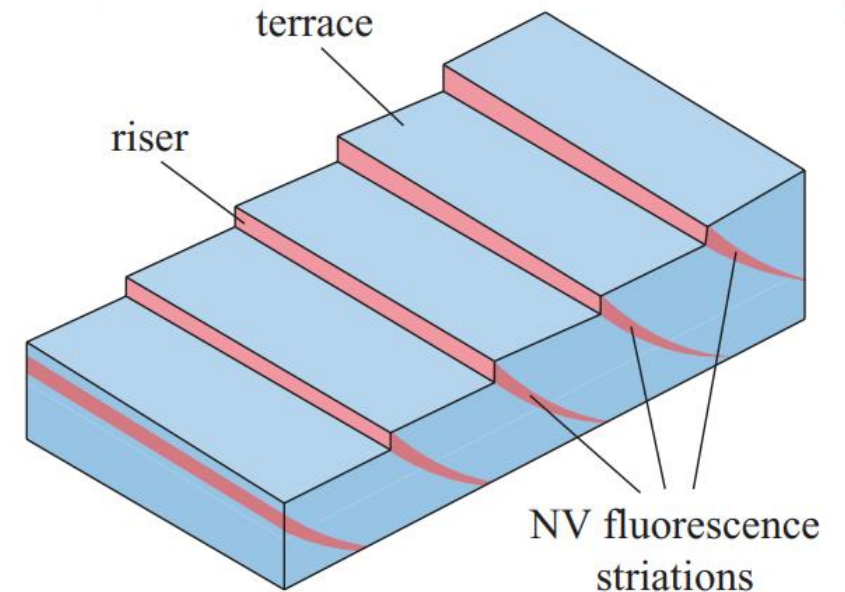
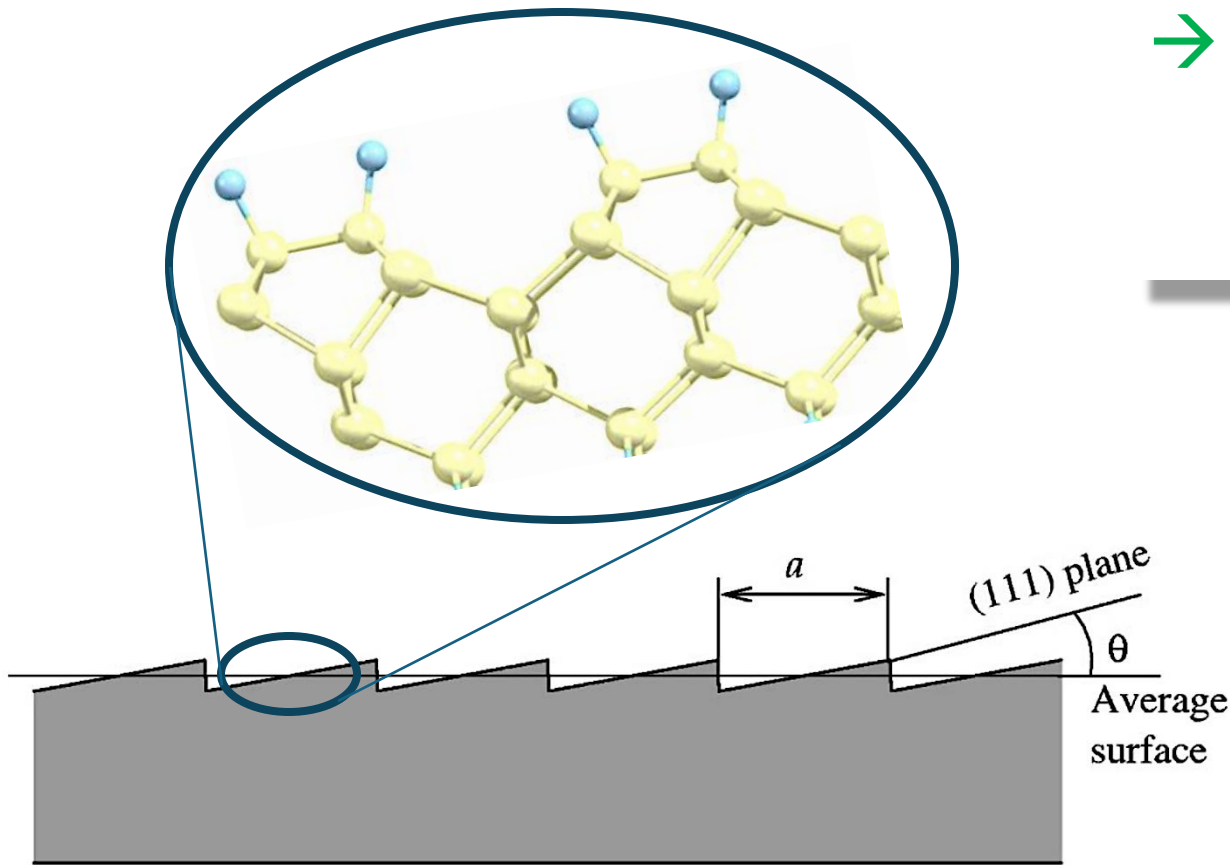
# Doping affected growth in diamond

**Nitrogen**



# Doping affected growth in diamond

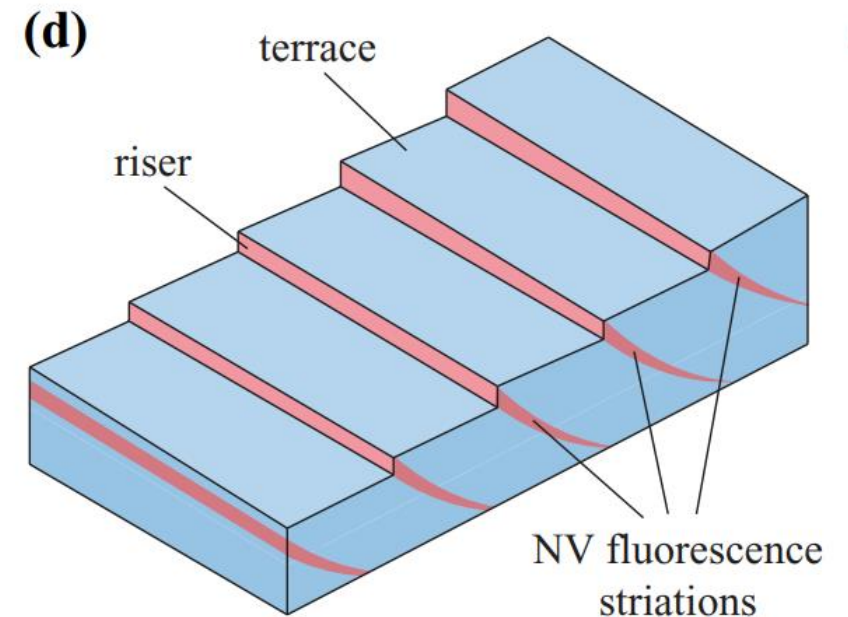
→ **Misorientation (miscut) angle affects step edge density, doping and morphology**



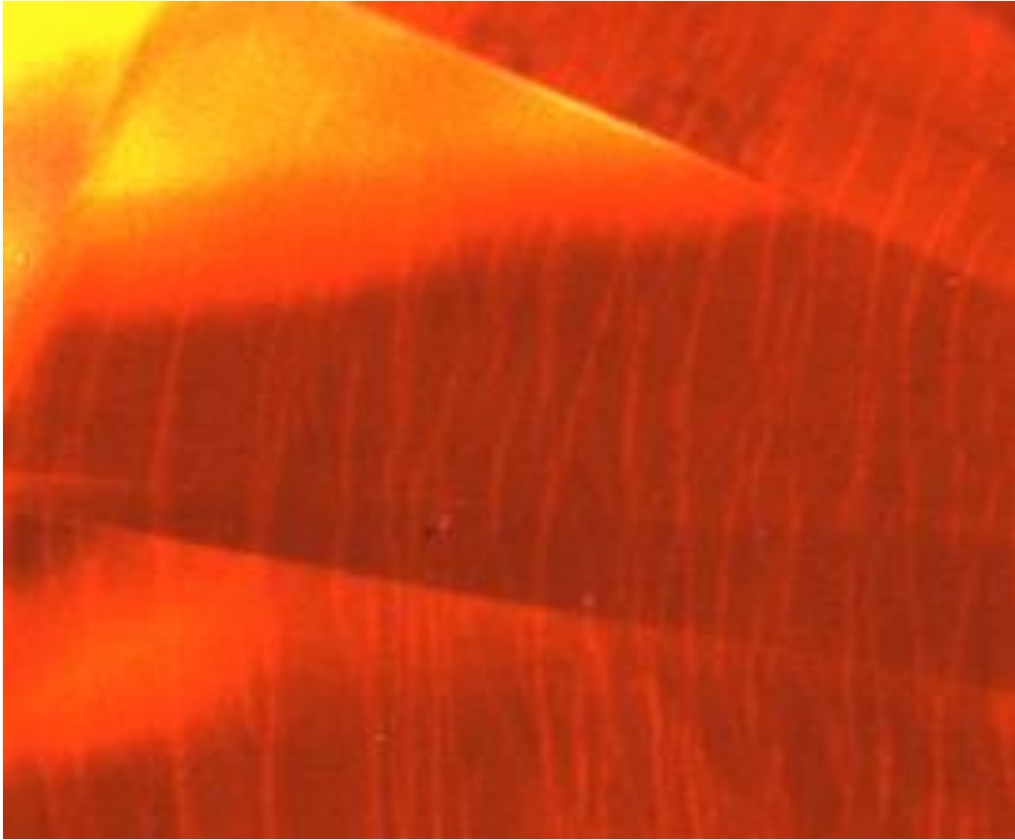
# Doping affected growth in diamond



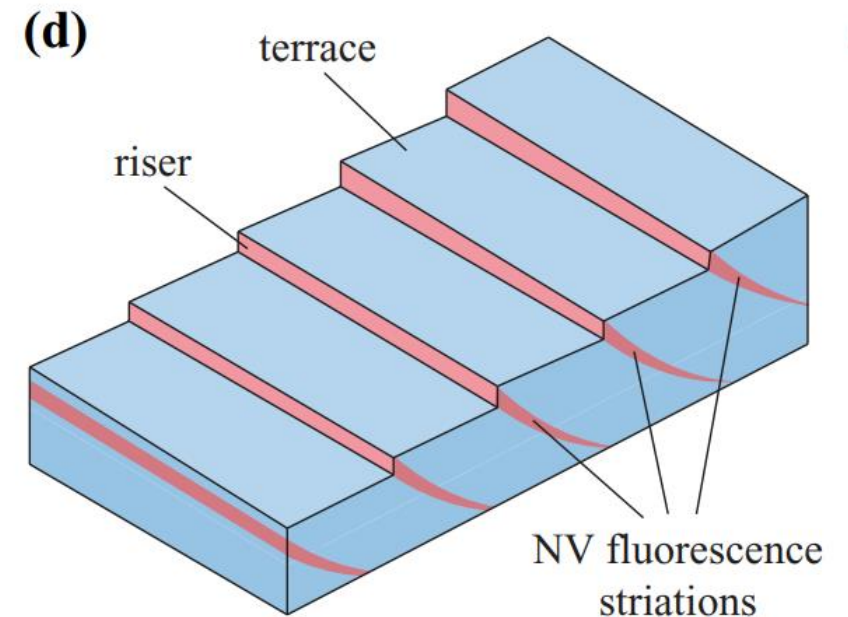
→ **Misorientation (miscut) angle affects step edge density, doping and morphology**



# Doping affected growth in diamond



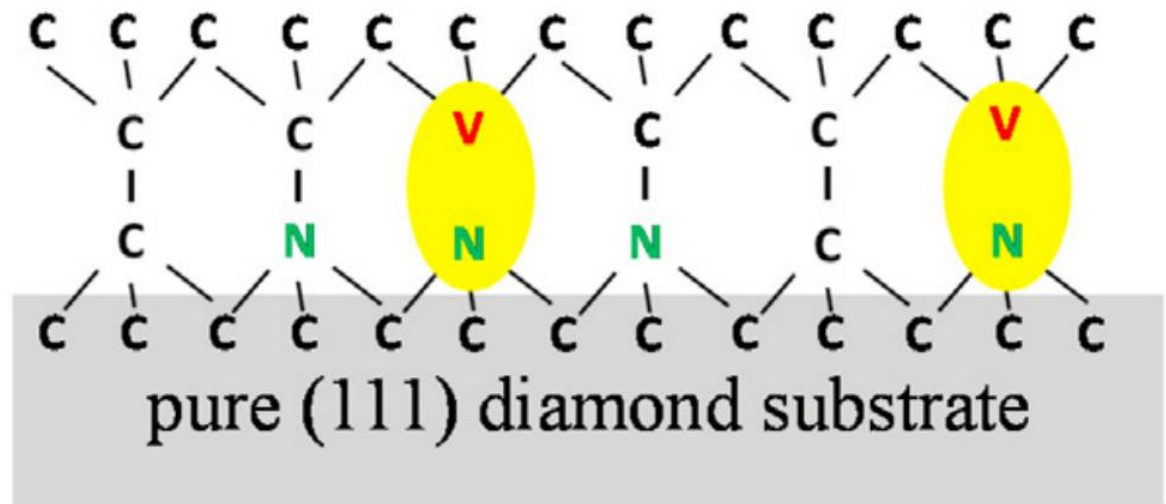
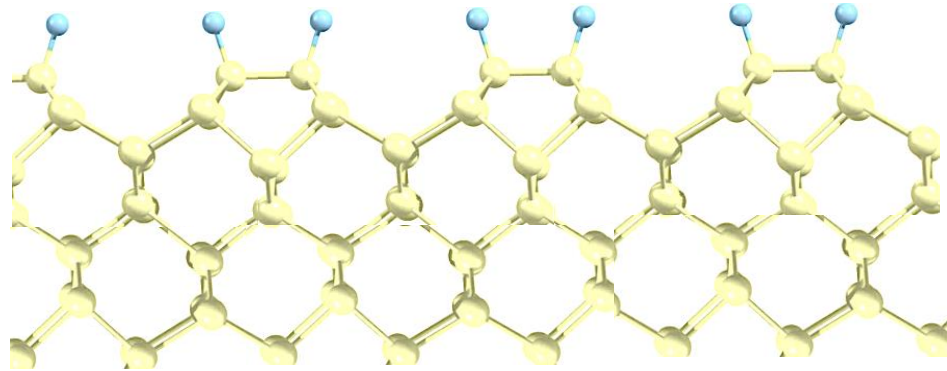
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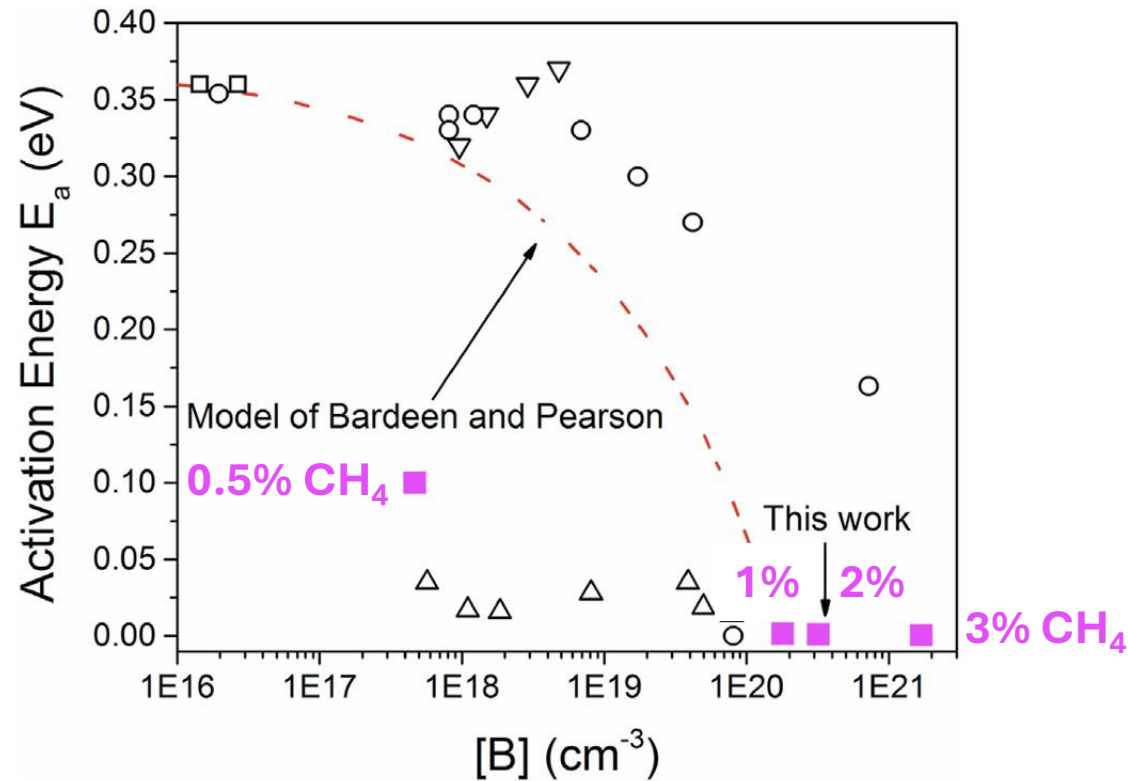
# Aligned NV centres by growth on [111] substrates



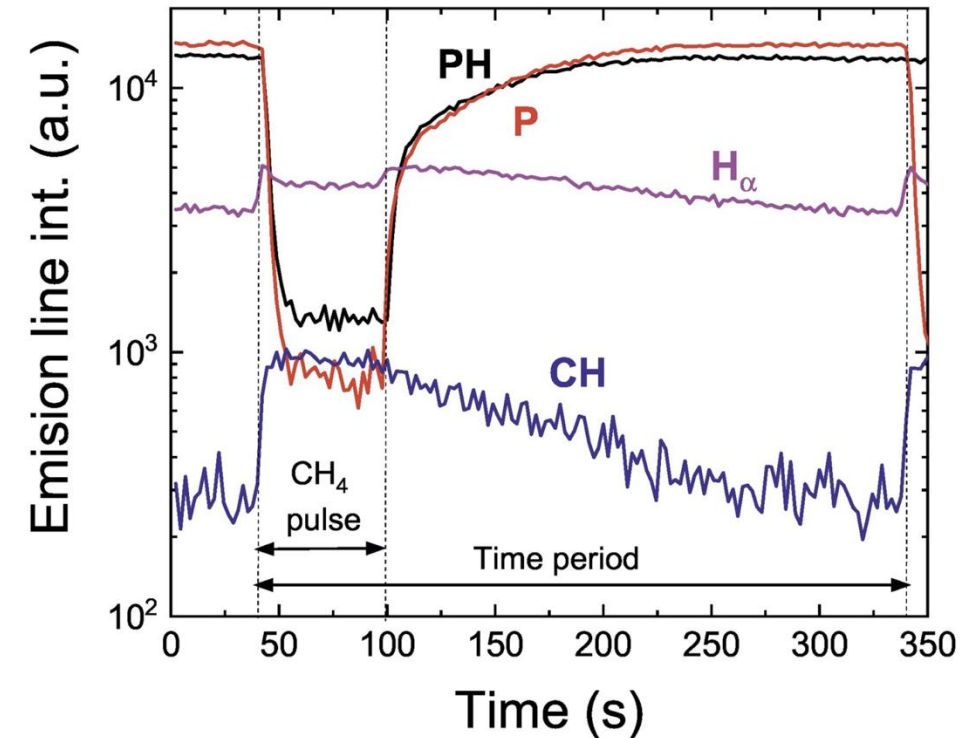
-  Vacancy
-  Nitrogen
-  Carbon



# Doping / growth interference

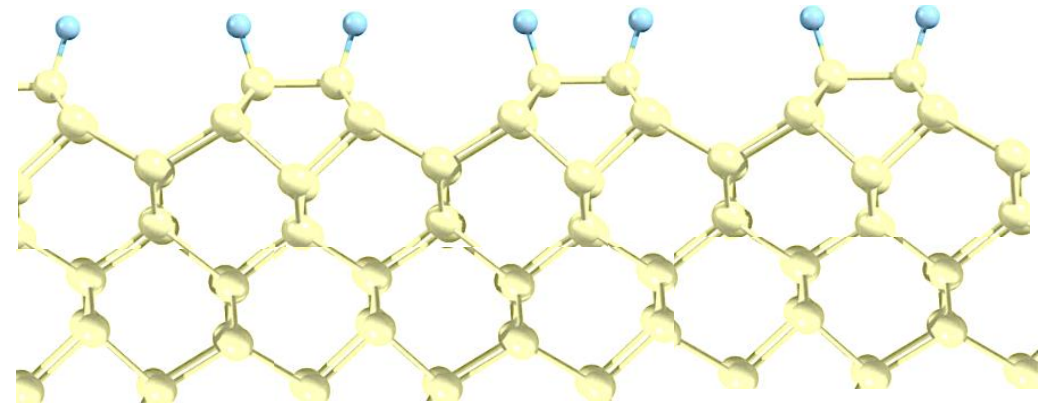
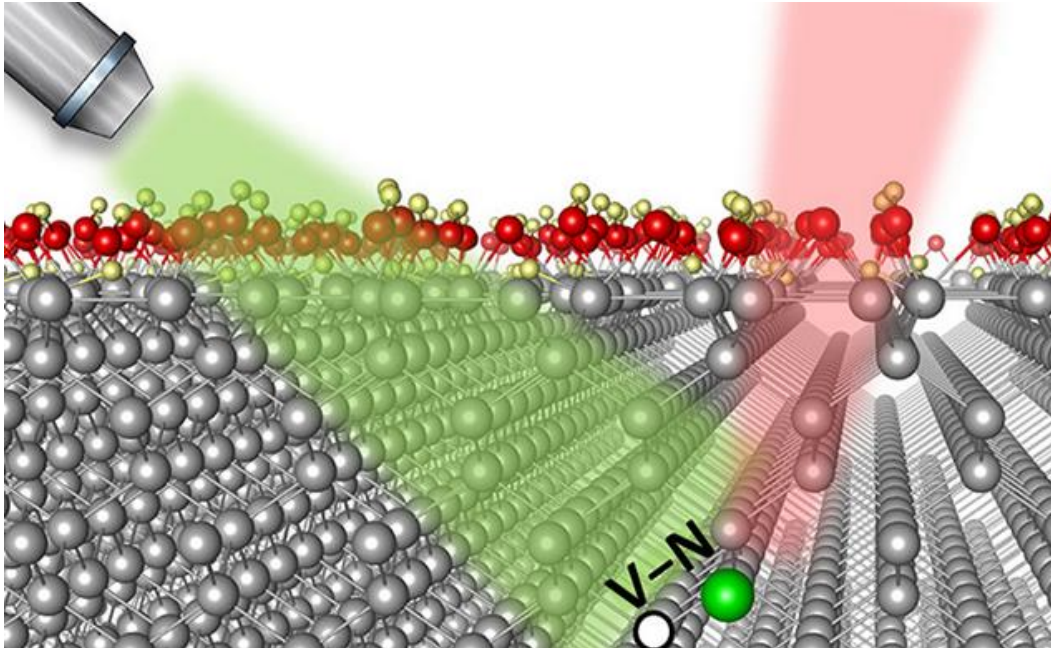


Increase  $\text{CH}_4 \rightarrow$  Increase  $[B]$



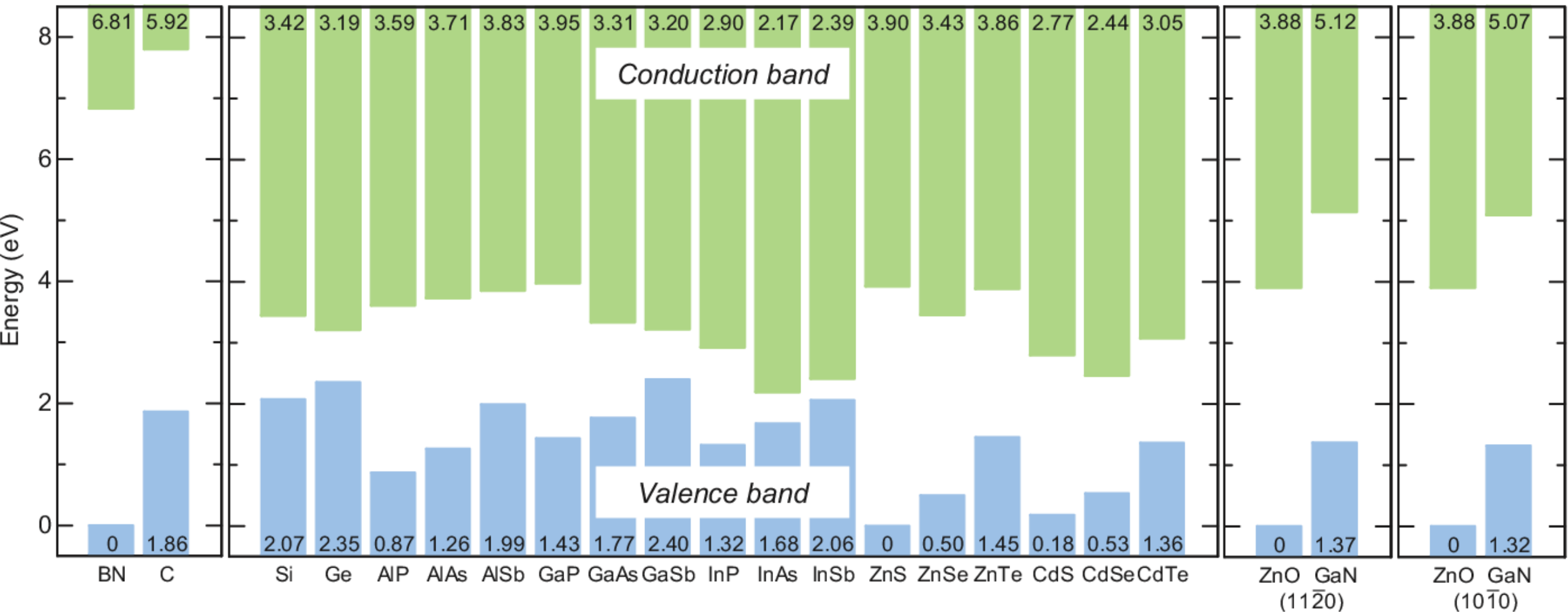
Increase  $\text{CH}_4 \rightarrow$  Decrease  $[P]$

# Surface termination peculiarities with diamond



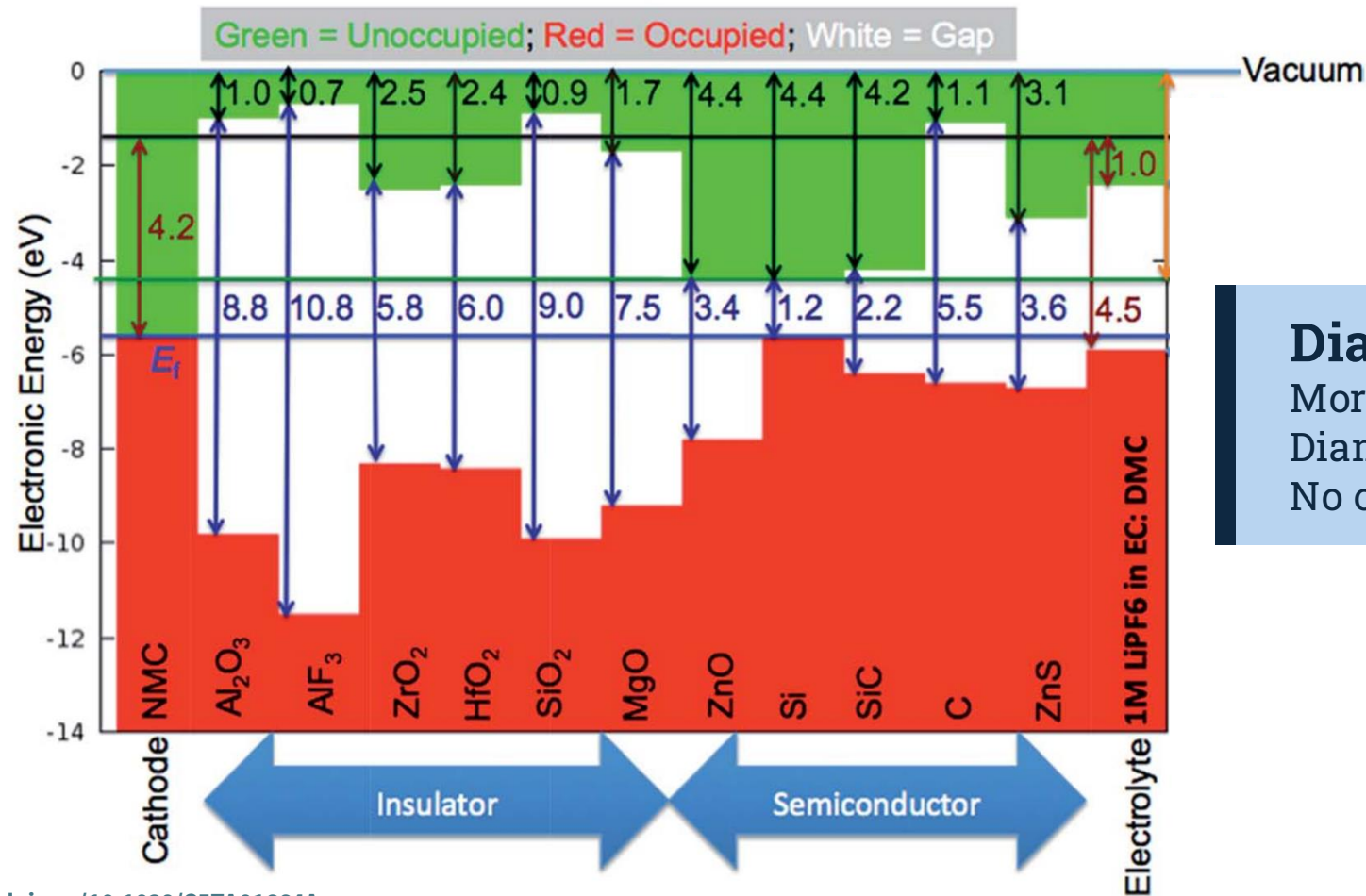
→ Why not use H-termination?

# Surface termination peculiarities with diamond



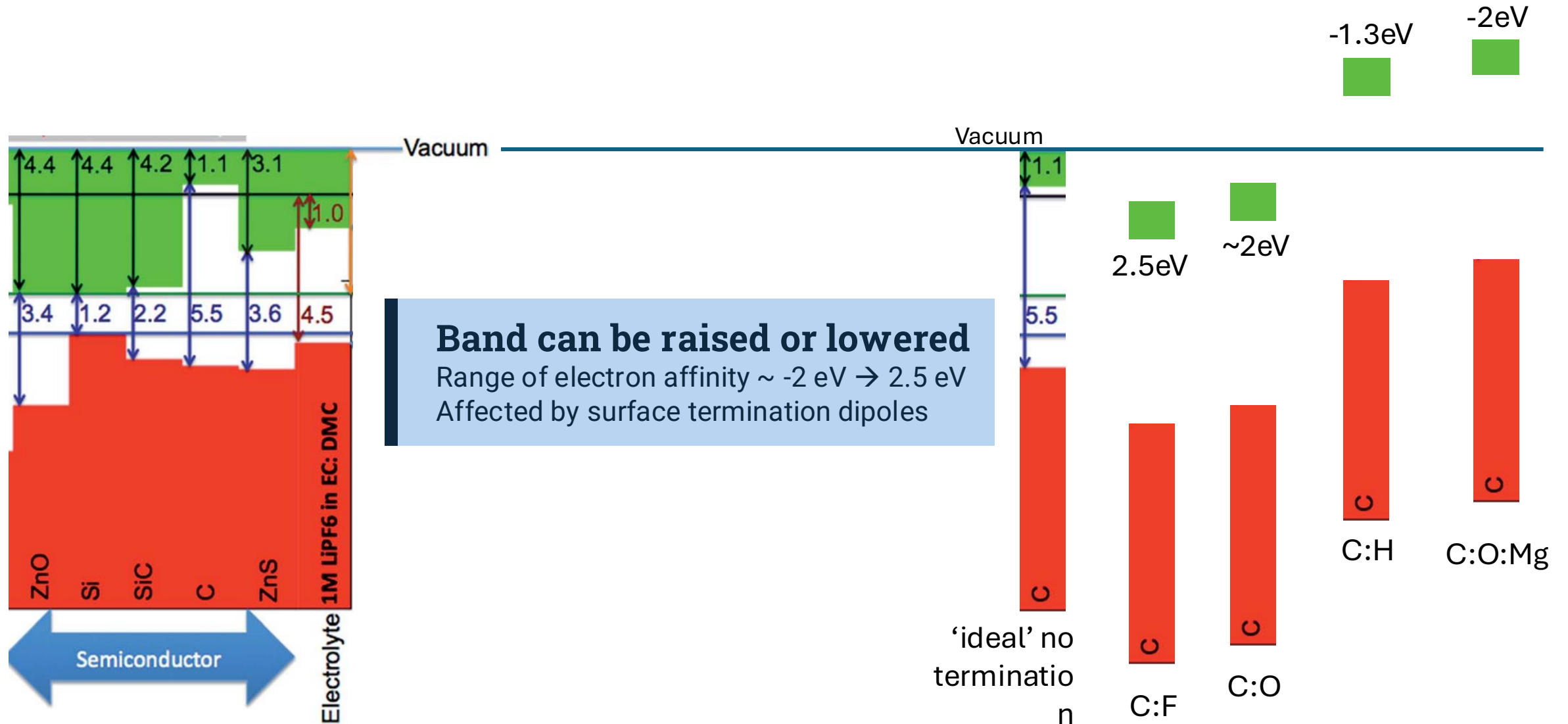
(DFT study) - DOI:10.1103/PHYSREVB.90.155405

# Surface termination peculiarities with diamond

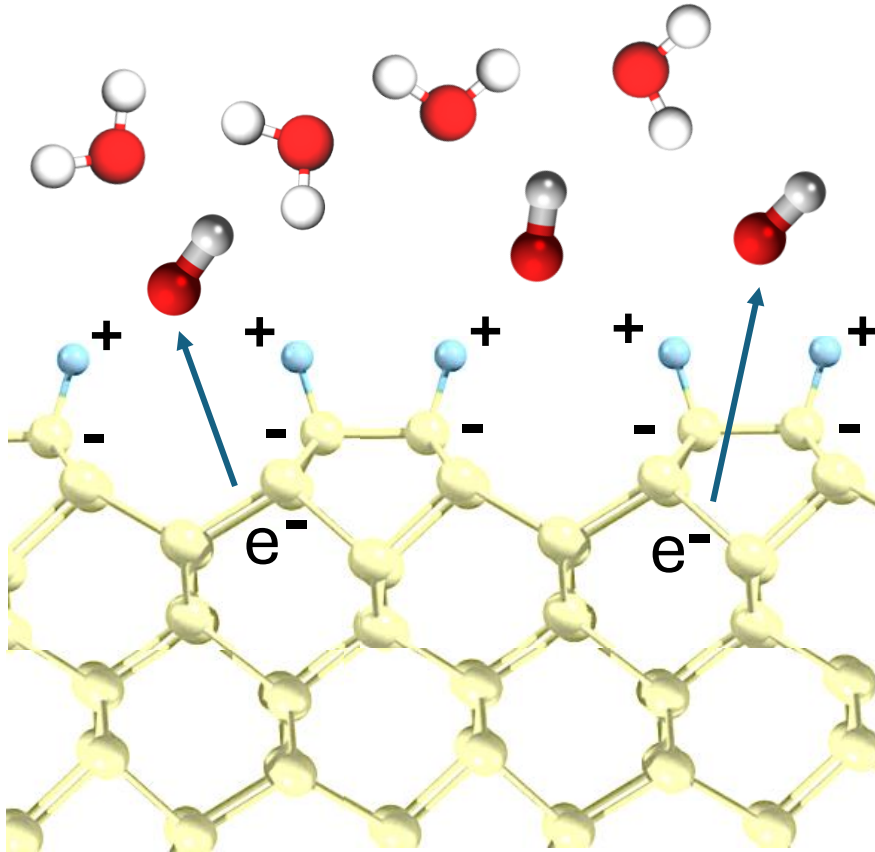


**Diamond CBM is very high**  
More consistent with classic insulators  
Diamond can be doped  
No oxide or surface polarization doping

# Surface termination affects band alignment

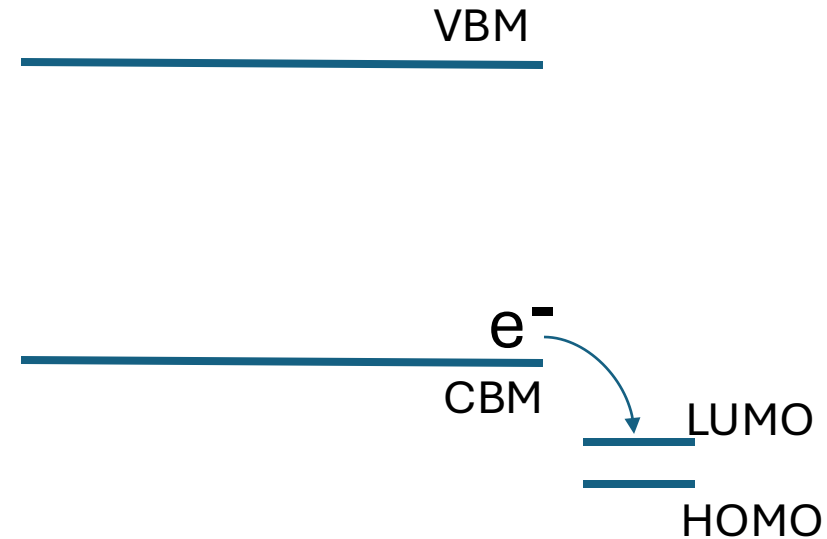


# H-termination induced surface conductivity

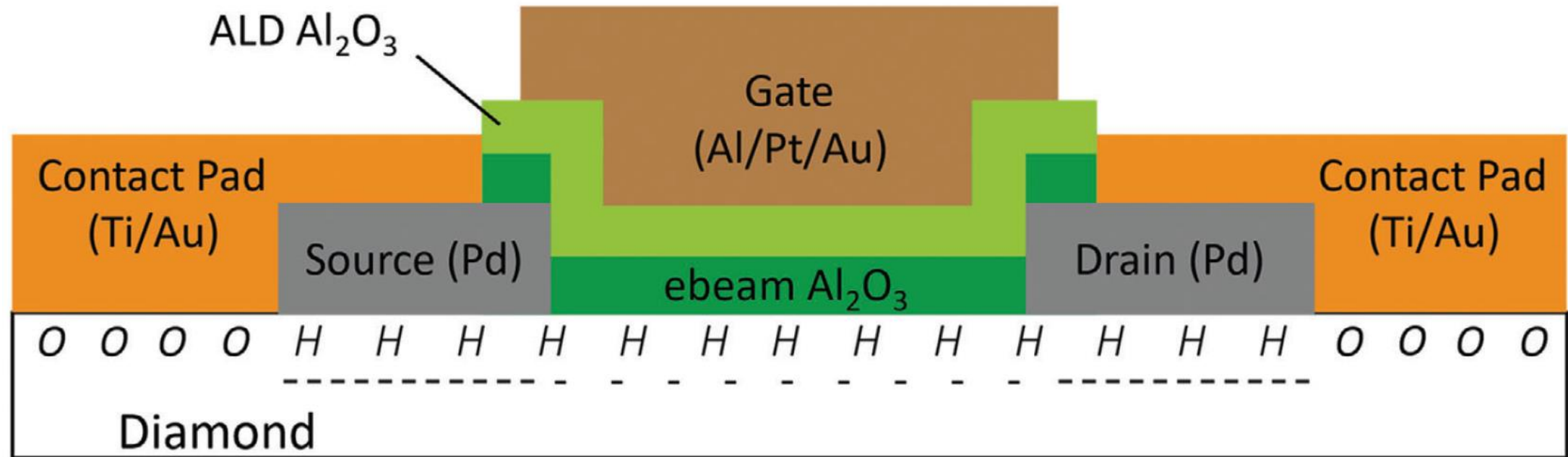


## C-H dipole induces electron transfer

External acceptor species become ionized  
Leaves behind holes at the diamond surface  
Behaves as a 2D-hole-gas (2DHG)



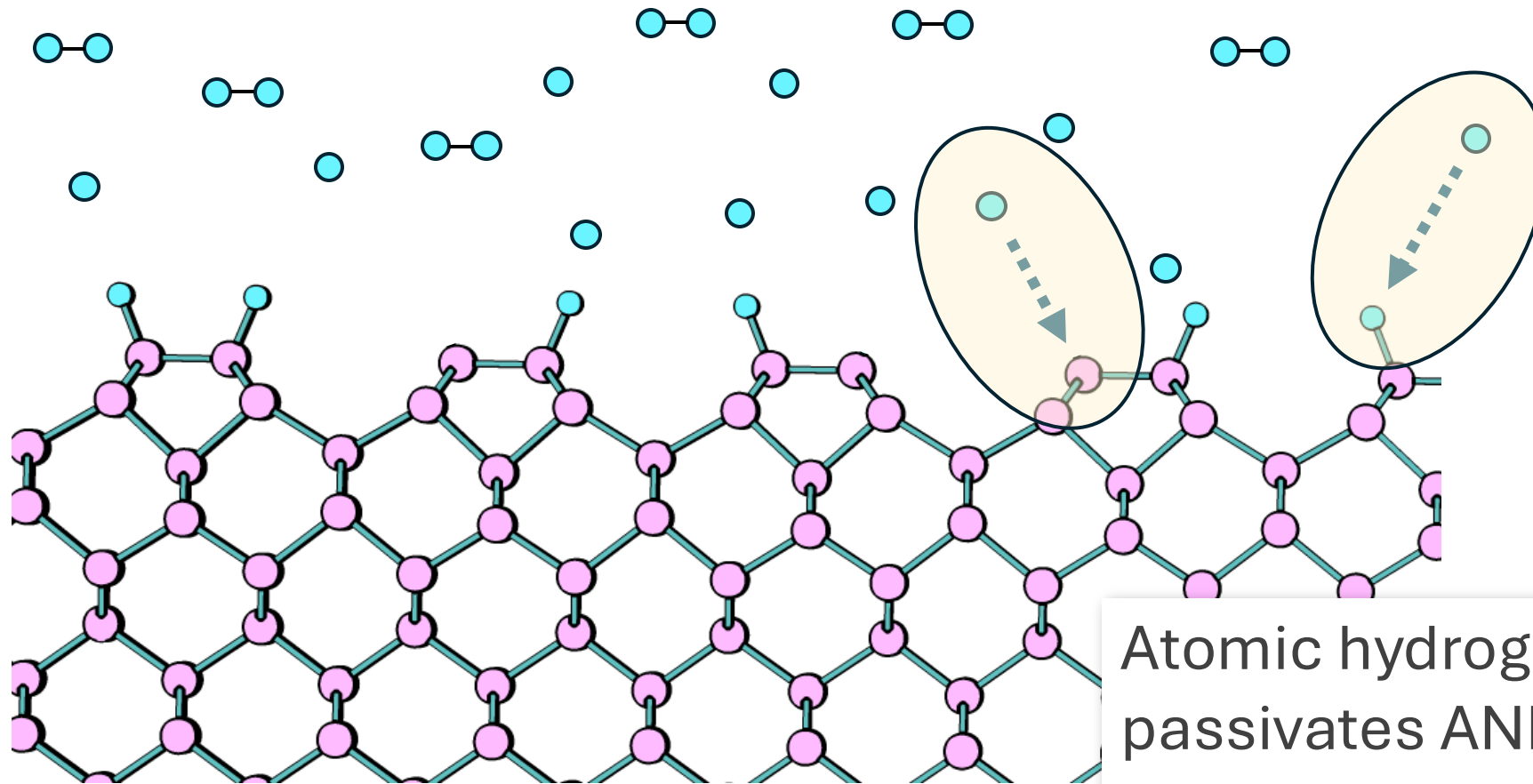
# Accumulation mode FET trials



D. Moran group Glasgow U.



# Hydrogen termination without diffusion/etching



Atomic hydrogen both passivates AND creates dangling bonds

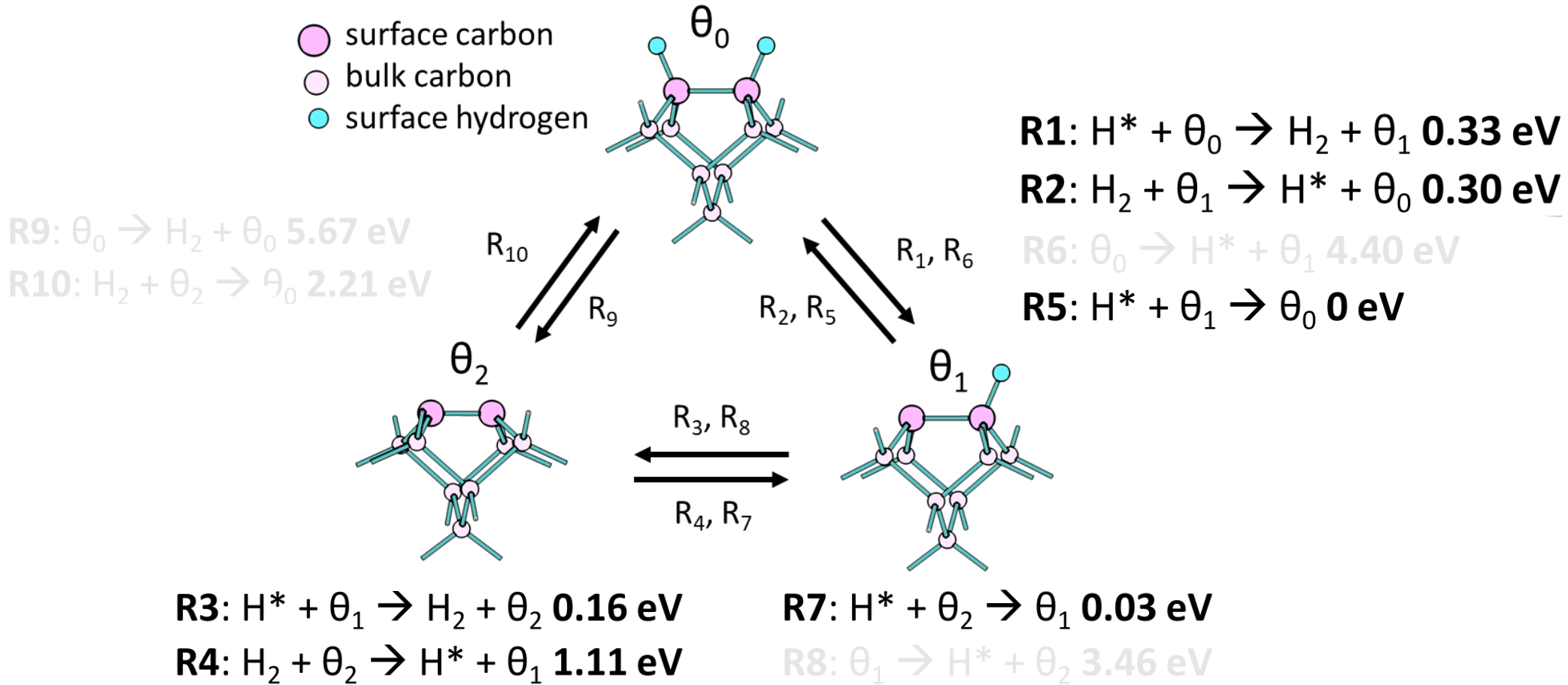
Barsukov, PPPL

→ Can we hydrogen terminate without atomic hydrogen?



# Modeling H-termination with $\text{H}^*$ and $\text{H}_2$

Y. Barsukov & I. Kaganovich  
Princeton Plasma Physics Laboratory

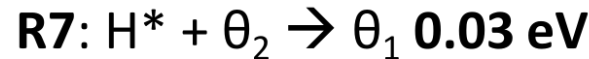
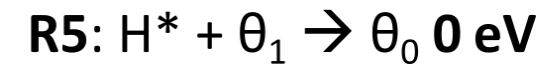
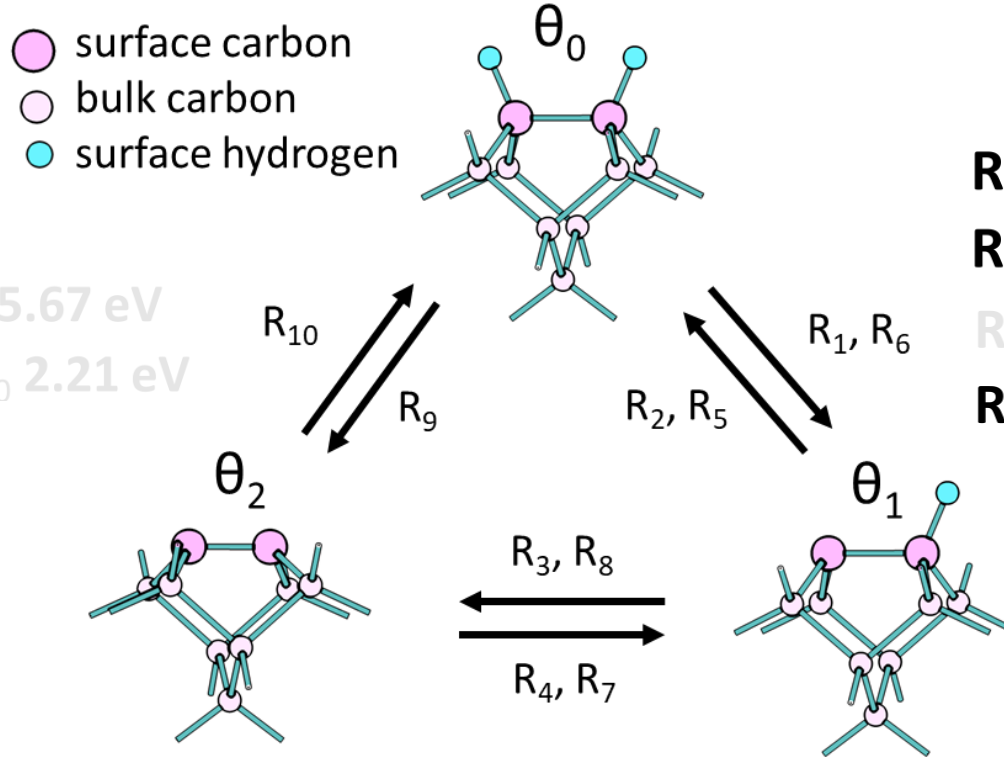


D. McCloskey *et al*, <https://doi.org/10.1002/admi.202400242>

# Modeling H-termination with $\text{H}^*$ and $\text{H}_2$

Y. Barsukov & I. Kaganovich

Model with fluxes and populations

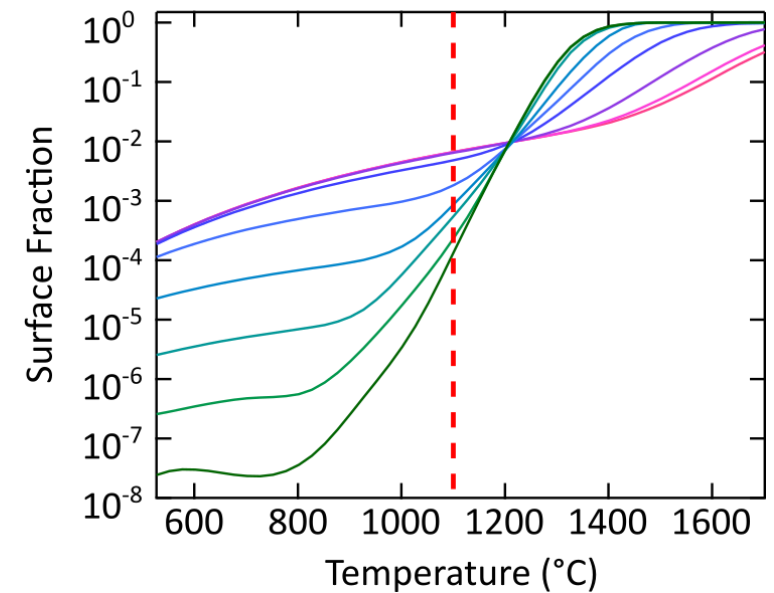
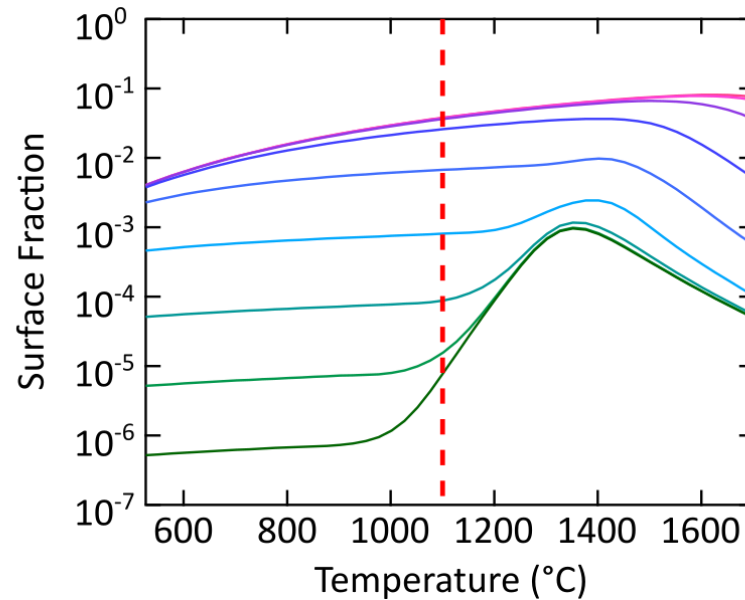
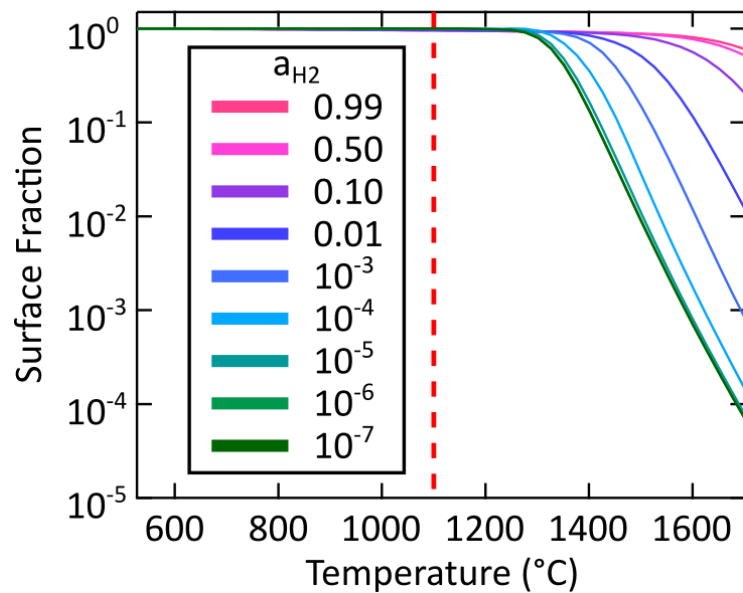
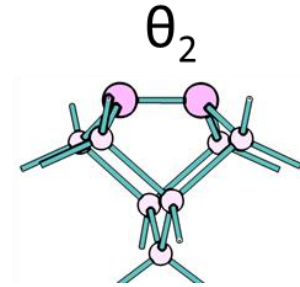
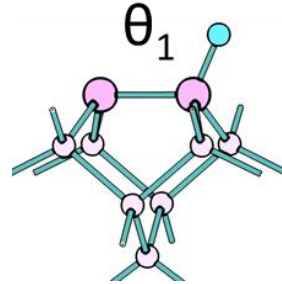
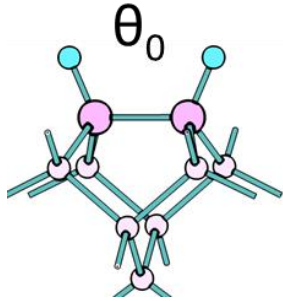


H<sub>2</sub> reactions important

Include thermal desorption of H

D. McCloskey *et al*, <https://doi.org/10.1002/admi.202400242>

# Modeling H-termination with $\text{H}^\cdot$ and $\text{H}_2$



D. McCloskey *et al*, <https://doi.org/10.1002/admi.202400242>

→  $\text{H}_2$  can be used to H-terminate diamond

# Conclusions

- Diamond growth by plasma is maturing for both QIS and Microelectronics applications
- Much plasma & plasma-surface/epitaxy science to be done in controlling dopants, cost, area
- Surface chemistry requires a focus on low-ion-damage processes

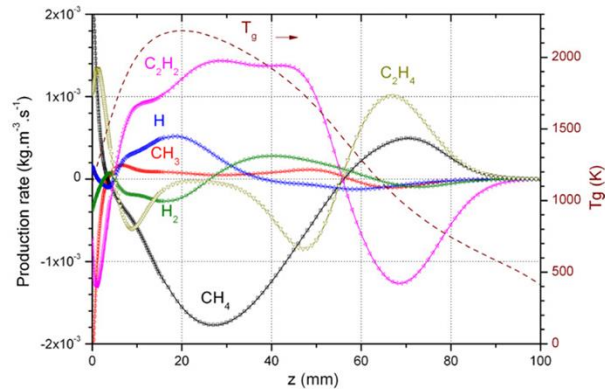


# Integrated Plasma Science for Quantum Diamond

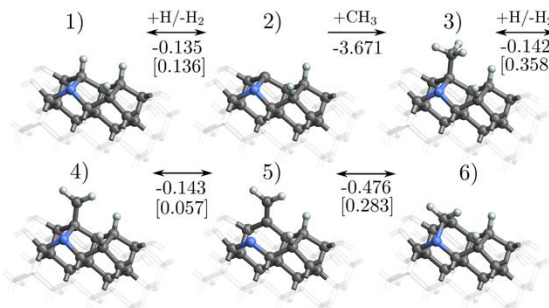


| Modeling

Igor Kaganovich

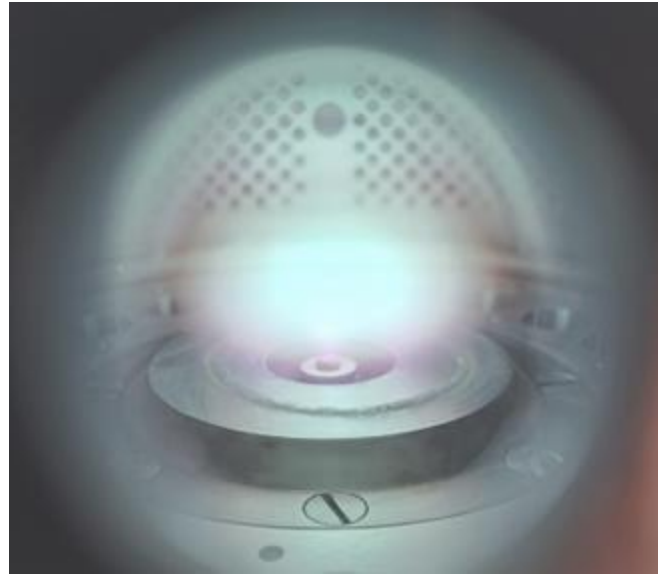


K. Hassouni, et al., J.Phys.D:Appl.Phys. 43(2010)153001



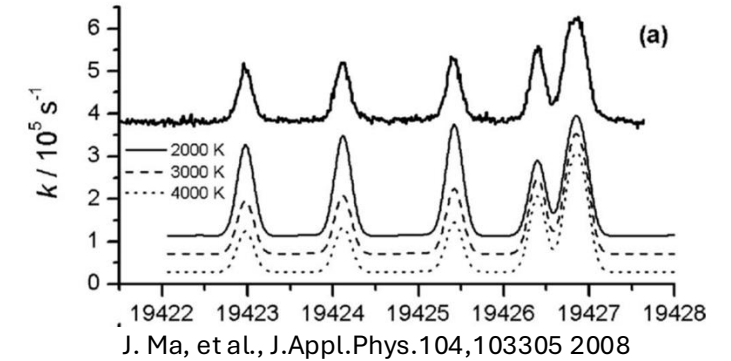
Oberg, Stacey, et al, 2021

| Growth

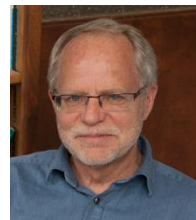


| Diagnostics

Yevgeny Raitses



J. Ma, et al., J.Appl.Phys.104,103305 2008



David Graves



Nathalie de Leon

